







ADS131M06-Q1 JAJSMP1 – AUGUST 2022

ADS131M06-Q1 車載用、6 チャネル、32kSPS、同時サンプリング、24 ビット、 デルタ・シグマ ADC

1 特長

- 車載アプリケーション用に AEC-Q100 認定済み:
 温度グレード 1:-40℃~+125℃、T_A
- 機能安全対応
 機能安全システムの設計に役立つ資料を利用可能
- 6 同時サンプリング差動入力
- プログラマブル・データ・レート:最大 32kSPS
- プログラマブル・ゲイン:最大 128
- ノイズ特性:
 - ゲイン = 1、4kSPS で 102dB のダイナミック・レンジ
 - ゲイン = 64、4kSPS で 80dB のダイナミック・レンジ
- 全高調波歪み:-100dB
- センサと直接接続できる高インピーダンス入力:
 - ゲイン 1、2、4 の場合 330kΩ の入力インピーダン
 - ゲイン 8、16、32、64、128 の場合 1MΩ 以上の入 カインピーダンス
- プログラム可能なチャネル間位相遅延較正:
 一分解能 = 244ns、f_{CLKIN} = 8.192MHz
- 高速起動:最初のデータは電源ランプから 0.5ms 以内
- 内蔵された負チャージ・ポンプにより、グランドより低い 入力信号に対応が可能
- チャネル間のクロストーク:-120dB
- 低ドリフトの内部基準電圧
- 通信およびレジスタ・マップに対する巡回冗長検査 (CRC)
- アナログおよびデジタル電源:2.7V~3.6V
- 低い消費電力: 3V AVDD および DVDD で 4.9mW
- パッケージ:32 ピン TQFP

2 アプリケーション

- バッテリ管理システム (BMS):
 - 電流シャント測定
 - 外付けの分圧抵抗を使用した電圧測定
 - サーミスタまたはアナログ出力温度センサを使用した温度測定
- EV 充電ステーション:
 - DC e メーター
 - AC e メーター
- エネルギー・ストレージ・システム (ESS)

3 概要

ADS131M06-Q1 は、six チャネルの同時サンプリング、 24 ビット、デルタ・シグマ (ΔΣ) A/D コンバータ (ADC) で す。ダイナミック・レンジが広く、消費電力が小さいため、バ ッテリ管理システム (BMS) に適しています。ADC 入力 は、双方向のバッテリ電流測定用のシャント抵抗、高電圧 測定用の抵抗分圧回路、または温度センサ (サーミスタや アナログ出力温度センサなど) に直接接続できます。

ADC チャネルは、センサ入力に応じて個別に構成可能で す。低ノイズのプログラマブル・ゲイン・アンプ (PGA) によ り、1~128 の範囲のゲインで低レベルの信号を増幅でき ます。さらに、このデバイスにはチャネル間位相較正レジス タ、オフセットおよびゲイン較正レジスタが内蔵されてお り、信号チェーンの誤差を除去するために役立ちます。

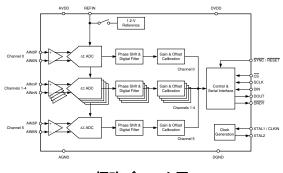
本デバイスには低ドリフトの 1.2V 基準電圧が内蔵されて いるため、プリント基板 (PCB)の面積を削減できます。デ ータ入力、データ出力、レジスタ・マップに対する任意の 巡回冗長検査 (CRC)は、通信の完全性を維持します。

この全部そろったアナログ・フロントエンド (AFE) ソリュー ションは、32 ピン TQFP パッケージで供給され、車載用 温度範囲の -40℃~+125℃で動作が規定されていま す。

パッケージ**情報**⁽¹⁾

| 部品番号 | パッケージ | 本体サイズ (公称) |
|--------------|-----------|-----------------|
| ADS131M06-Q1 | TQFP (32) | 5.00mm × 5.00mm |

(1) 利用可能なパッケージについては、このデータシートの末尾にある注文情報を参照してください。



概略ブロック図



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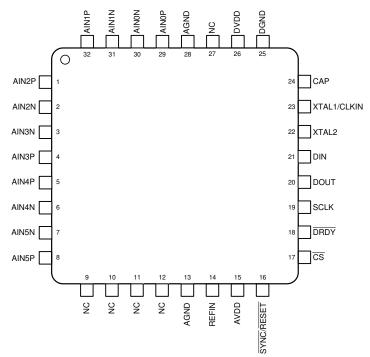
4 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

| DATE | REVISION | NOTES |
|-------------|----------|-----------------|
| August 2022 | * | Initial Release |



5 Pin Configuration and Functions



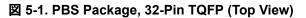


表 5-1. Pin Functions

| F | PIN | I/O | DESCRIPTION ⁽¹⁾ |
|-------|--------|----------------|--|
| NAME | NO. | | DESCRIPTION |
| AGND | 13, 28 | Supply | Analog ground |
| AINON | 30 | Analog input | Negative analog input 0 |
| AIN0P | 29 | Analog input | Positive analog input 0 |
| AIN1N | 31 | Analog input | Negative analog input 1 |
| AIN1P | 32 | Analog input | Positive analog input 1 |
| AIN2N | 2 | Analog input | Negative analog input 2 |
| AIN2P | 1 | Analog input | Positive analog input 2 |
| AIN3N | 3 | Analog input | Negative analog input 3 |
| AIN3P | 4 | Analog input | Positive analog input 3 |
| AIN4N | 6 | Analog input | Negative analog input 4 |
| AIN4P | 5 | Analog input | Positive analog input 4 |
| AIN5N | 7 | Analog input | Negative analog input 5 |
| AIN5P | 8 | Analog input | Positive analog input 5 |
| AVDD | 15 | Supply | Analog supply. Connect a 1-µF capacitor to AGND. |
| САР | 24 | Analog output | Digital low-dropout (LDO) regulator output. Connect a 220-nF capacitor to DGND. |
| CS | 17 | Digital input | Chip select; active low |
| DGND | 25 | Supply | Digital ground |
| DIN | 21 | Digital input | Serial data input |
| DOUT | 20 | Digital output | Serial data output |
| DRDY | 18 | Digital output | Data ready; active low |
| DVDD | 26 | Supply | Digital I/O supply. Connect a 1-µF capacitor to DGND. |



表 5-1. Pin Functions (continued)

| P | IN | I/O | DESCRIPTION ⁽¹⁾ |
|----------------|------|----------------|--|
| NAME | NO. | | DESCRIPTION / |
| NC | 9-12 | — | Leave unconnected or connect to AGND |
| NC 27 | | — | Leave unconnected or connect to AGND |
| REFIN 14 | | Analog input | External reference voltage input. (2) |
| SCLK | 19 | Digital input | Serial data clock |
| SYNC/RESET | 16 | Digital input | Conversion synchronization or system reset; active low |
| XTAL1/CLKIN 23 | | Digital input | Main clock input, or crystal oscillator input |
| XTAL2 | 22 | Digital output | Crystal oscillator excitation ⁽³⁾ |

(1) (2) See the Unused Inputs and Outputs section for details on how to connect unused pins.

Do not place any capacitance on REFIN if the current-detect mode is used.

(3) See the Clocking and Power Modes section for more information regarding synchronization and how to implement the clocking scheme for optimized device performance.



6 Specifications

6.1 Absolute Maximum Ratings

see (1)

| | | MIN | MAX | UNIT |
|-------------------------|---|------------|------------|------|
| | AVDD to AGND | -0.3 | 3.9 | |
| | AGND to DGND | -0.3 | 0.3 | |
| Power-supply voltage | DVDD to DGND | -0.3 | 3.9 | V |
| | DVDD to DGND, CAP tied to DVDD | -0.3 | 2.2 | |
| | CAP to DGND | -0.3 | 2.2 | |
| Analog input voltage | AINxP, AINxN | AGND – 1.6 | AVDD + 0.3 | V |
| Reference input voltage | REFIN | AGND – 0.3 | AVDD + 0.3 | V |
| Digital input voltage | CS, XTAL1/CLKIN, DIN, SCLK, SYNC/RESET, XTAL2 | DGND – 0.3 | DVDD + 0.3 | V |
| Input current | Continuous, all pins except power-supply pins | -10 | 10 | mA |
| Tomporaturo | Junction, T _J | | 150 | °C |
| Temperature | Storage, T _{stg} | -60 | 150 | C |

(1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

6.2 ESD Ratings

| | | | | VALUE | UNIT |
|--------------------|-------------------------|--|---------------------------|-------|------|
| V | Electrostatic discharge | Human-body model (HBM), per AEC Q100-002 ⁽¹⁾ HBM ESD classification level 2 | | ±2000 | N |
| V _(ESD) | Electrostatic discharge | Charged-device model (CDM), | Corner pins | ±750 | |
| | | per AEC Q100-011 CDM ESD classification level C4B | All other non-corner pins | ±500 | |

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.



6.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

| | | | MIN | NOM | MAX | UNIT |
|----------------------|---------------------------------------|---|------------------------------------|-------|-----------------------------------|--------|
| POWER | RSUPPLY | | | | | |
| | | AVDD to AGND, normal operating modes | 2.7 | 3.0 | 3.6 | |
| | Analog power supply | AVDD to AGND, standby and current-detect modes | 2.4 | 3.0 | 3.6 | V |
| | | AGND to DGND | -0.3 | 0 | 0.3 | |
| | | DVDD to DGND | 2.7 | 3.0 | 3.6 | |
| | Digital power supply | DVDD to DGND, DVDD shorted to CAP (digital LDO bypassed) | 1.65 | 1.8 | 2 | V |
| ANALO | G INPUTS | | | | | |
| V _{AINxP} , | Absolute input voltage ⁽¹⁾ | Gain = 1, 2, or 4 | AGND – 1.3 | | AVDD | V |
| V _{AINxN} | Absolute input voltage () | Gains = 8, 16, 32, 64 or 128 | AGND – 1.3 | | AVDD - 1.8 | v |
| V | | Using internal reference, $V_{IN} = V_{AINxP} - V_{AINxN}$ | –V _{REF} / Gain | | V _{REF} / Gain | |
| V _{IN} | Differential input voltage | Using external reference, $V_{IN} = V_{AINxP} - V_{AINxN}$ | –0.96 × V _{REF} / Gain | | 0.96 × V _{REF} / Gain | V |
| VOLTAC | GE REFERENCE INPUT | 1 | | | I | |
| V _{REFIN} | Reference input voltage | | 1.1 | 1.25 | 1.3 | V |
| EXTER | NAL CLOCK SOURCE | | | | | |
| | | High-resolution mode, Gain = 1 or 2 | 0.3 | 8.192 | 8.4 | |
| £ | | High-resolution mode, Gain > 2 | 0.3 | 8.192 | 8.2 | MHz |
| f _{CLKIN} | External clock frequency | Low-power mode | 0.3 | 4.096 | 4.15 | IVITIZ |
| | | Very-low-power mode | 0.3 | 2.048 | 2.08 | |
| | Duty cycle | | 40 | 50 | 60 | % |
| DIGITAI | LINPUTS | | | | I | |
| | Input voltage | | DGND | | DVDD | V |
| TEMPE | RATURE RANGE | | | | I | |
| T _A | Operating ambient temperat | ure | -40 | | 125 | °C |

(1) The subscript "x" signifies the channel. For example, the positive analog input to channel 0 is named AIN0P. See the *Pin Configurations and Functions* section for the pin names.

6.4 Thermal Information

| | | ADS131M06-Q1 | |
|-----------------------|--|--------------|------|
| | THERMAL METRIC ⁽¹⁾ | PBS (TQFP) | UNIT |
| | | 32 PINS | - |
| R _{θJA} | Junction-to-ambient thermal resistance | 81.9 | °C/W |
| R _{0JC(top)} | Junction-to-case (top) thermal resistance | 26.0 | °C/W |
| R _{θJB} | Junction-to-board thermal resistance | 32.7 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 1.1 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 32.5 | °C/W |
| R _{0JC(bot)} | Junction-to-case (bottom) thermal resistance | N/A | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.



6.5 Electrical Characteristics

minimum and maximum specifications apply from $T_A = -40^{\circ}$ C to $+125^{\circ}$ C; typical specifications are at $T_A = 25^{\circ}$ C; all specifications are at AVDD = 3 V, DVDD = 3 V, f_{CLKIN} = 8.192 MHz, data rate = 4 kSPS, gain = 1, all channels enabled, global-chop mode disabled, using internal reference with 100-nF tied to REFIN pin, and internal oscillator disabled (unless otherwise noted).

| | PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
|-------------------|----------------------------------|--|-----------------------------|-----|-------------------|
| ANALO | G INPUTS | | | | |
| Z _{in} | Differential input impedance | Gain = 1, 2, or 4 | 330 | | kΩ |
| l _b | Input bias current | Gain = 8, 16, 32, 64, or 128, inputs shorted to ground | ±1 | | μA/V |
| | ARACTERISTICS | | | | 1 |
| | Resolution | | 24 | | Bits |
| | Gain settings | | 1, 2, 4, 8, 16, 32, 64, 128 | | |
| | | High-resolution mode, f _{CLKIN} = 8.192 MHz | 250 | 32k | |
| f _{DATA} | Data rate | Low-power mode, f _{CLKIN} = 4.096 MHz | 125 | 16k | SPS |
| | | Very low-power mode, f _{CLKIN} = 2.048 MHz | 62.5 | 8k | |
| | Startup time | Measured from supplies at 90% to first DRDY falling edge | 0.5 | | ms |
| ADC PE | | | | | 1 |
| INL | Integral nonlinearity (best fit) | | 7.5 | | ppm of FSR |
| | | | ±240 | | |
| | Offset error (input referred) | Global-chop mode | ±32 | | μV |
| | 0 | | 215 | | |
| | Offset drift | Global-chop mode | 105 | | nV/°C |
| | Gain error | | ±0.3% | | |
| | | Excluding voltage reference error, gain = 1 | 5 | | |
| | Gain drift | Including internal voltage reference error, gain = 1 | 10 | 20 | ppm/°C |
| | | Including internal voltage reference error, gain = 32 | 15 | | |
| | Long-term gain drift | 1000 hours at 85°C, including internal voltage reference error | 385 | | ppm |
| | Common-mode rejection | At dc | 100 | | dB |
| CMRR | ratio | f _{CM} = 50 Hz or 60 Hz | 94 | | ud l |
| | | AVDD at DC | 80 | | |
| | Deuren europhyneisetien netie | DVDD at DC | 100 | | |
| PSRR | Power-supply rejection ratio | AVDD supply, f _{PS} = 50 Hz or 60 Hz | 78 | | dB |
| | | DVDD supply, f _{PS} = 50 Hz or 60 Hz | 90 | | |
| | | | 5.4 | | |
| | Input referred noise | During fast startup | 1500 | | μV _{RMS} |
| | | Gain = 1 | 99 102 | | |
| | Dynamic range | Gain = 64 | 80 | | dB |
| | | All other gain settings | See 表 7-1 | | |
| | Crosstalk | f _{IN} = 50 Hz or 60 Hz | -120 | | dB |
| SND | Signal to paics ratio | f_{IN} = 50 Hz or 60 Hz, gain = 1, V _{IN} = -0.5 dBFS, normalized | 101 | | 40 |
| SNR | Signal-to-noise ratio | f_{IN} = 50 Hz or 60 Hz, gain = 64, V _{IN} = -0.5 dBFS, normalized | 80 | | dB |

6.5 Electrical Characteristics (continued)

minimum and maximum specifications apply from $T_A = -40^{\circ}$ C to +125°C; typical specifications are at $T_A = 25^{\circ}$ C; all specifications are at AVDD = 3 V, DVDD = 3 V, f_{CLKIN} = 8.192 MHz, data rate = 4 kSPS, gain = 1, all channels enabled, global-chop mode disabled, using internal reference with 100-nF tied to REFIN pin, and internal oscillator disabled (unless otherwise noted).

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------|---------------------------------------|--|----------|-------|----------|--------|
| THD | Total harmonic distortion | $f_{\rm IN}$ = 50 Hz or 60 Hz (up to 50 harmonics), $V_{\rm IN}$ = –0.5 dBFS | | -100 | | dB |
| SFDR | Spurious-free dynamic range | $f_{\rm IN}$ = 50 Hz or 60 Hz (up to 50 harmonics), $V_{\rm IN}$ = –0.5 dBFS | | 103 | | dB |
| INTERN | NAL VOLTAGE REFERENCE | | 1 | | | |
| V _{REF} | Internal reference voltage | | | 1.2 | | V |
| | Accuracy | T _A = 25°C | | ±0.1% | | |
| | Temperature drift | | | 8 | | ppm/°C |
| | Long-term reference drift | 1000 hours at 85°C | | 340 | | ppm |
| DIGITA | L INPUTS/OUTPUTS | | | | | |
| V _{IL} | Logic input level, low | | DGND | | 0.2 DVDD | V |
| V _{IH} | Logic input level, high | | 0.8 DVDD | | DVDD | V |
| V _{OL} | Logic output level, low | $I_{OL} = -1 \text{ mA}$ | | | 0.2 DVDD | V |
| V _{OH} | Logic output level, high | I _{OH} = 1 mA | 0.8 DVDD | | | V |
| I _{IN} | Input current | DGND < V _{Digital Input} < DVDD | -1 | | 1 | μA |
| POWEF | RSUPPLY | | 1 | | | |
| | | High-resolution mode | | 5.0 | 5.9 | |
| | | Low-power mode | | 2.6 | 3.1 | mA |
| I _{AVDD} | Analog supply current | Very low-power mode | | 1.5 | 1.8 | |
| | | Current-detect mode | | 1.4 | | |
| | | Standy mode | | 0.35 | | μA |
| | | High-resolution mode | | 0.55 | 0.7 | |
| | | Low-power mode | | 0.28 | 0.36 | |
| I _{DVDD} | Digital supply current ⁽¹⁾ | Very low-power mode | | 0.14 | 0.19 | mA |
| | | Current-detect mode | | 0.1 | | |
| | | Standby mode | | 1.1 | | μA |
| | | High-resolution mode | | 16.7 | | |
| | | Low-power mode | | 8.6 | | |
| P _D | Power dissipation | Very low-power mode | | 4.9 | | mW |
| | | Current-detect mode | | 4.5 | | |
| | | Standby mode | | 4.4 | | μW |

(1) Currents measured with SPI idle and oscillator disabled.



6.6 Timing Requirements

over operating ambient temperature range, DOUT load: 20 pF || 100 kΩ (unless otherwise noted)

| | | MIN | NOM MAX | UNIT ⁽¹⁾ |
|----------------------|--|------|---------|---------------------|
| 1.65 V ≤ D | VDD ≤ 2.0 V | | | |
| t _{w(CLL)} | Pulse duration, CLKIN low | 49 | | ns |
| t _{w(CLH)} | Pulse duration, CLKIN high | 49 | | ns |
| t _{c(SC)} | SCLK period | 64 | | ns |
| t _{w(SCL)} | Pulse duration, SCLK low | 32 | | ns |
| t _{w(SCH)} | Pulse duration, SCLK high | 32 | | ns |
| t _{d(CSSC)} | Delay time, first SCLK rising edge after CS falling edge | 16 | | ns |
| t _{d(SCCS)} | Delay time, CS rising edge after final SCLK falling edge | 10 | | ns |
| t _{w(CSH)} | Pulse duration, CS high | 20 | | ns |
| t _{su(DI)} | Setup time, DIN valid before SCLK falling egde | 5 | | ns |
| t _{h(DI)} | Hold time, DIN valid after SCLK falling edge | 10 | | ns |
| t _{w(RSL)} | Pulse duration, SYNC/RESET low to generate device reset | 2048 | | t _{CLKIN} |
| t _{w(SYL)} | Pulse duration, SYNC/RESET low for synchronization | 1 | 2047 | t _{CLKIN} |
| t _{su(SY)} | Setup time, SYNC/RESET valid before CLKIN rising edge | 10 | | ns |
| 2.7 V ≤ DV | DD ≤ 3.6 V | I | | |
| t _{w(CLL)} | Pulse duration, CLKIN low | 49 | | ns |
| t _{w(CLH)} | Pulse duration, CLKIN high | 49 | | ns |
| t _{c(SC)} | SCLK period | 40 | | ns |
| t _{w(SCL)} | Pulse duration, SCLK low | 20 | | ns |
| t _{w(SCH)} | Pulse duration, SCLK high | 20 | | ns |
| t _{d(CSSC)} | Delay time, first SCLK rising edge after CS falling edge | 16 | | ns |
| t _{d(SCCS)} | Delay time, CS rising edge after final SCLK falling edge | 10 | | ns |
| t _{w(CSH)} | Pulse duration, CS high | 15 | | ns |
| t _{su(DI)} | Setup time, DIN valid before SCLK falling egde | 5 | | ns |
| t _{h(DI)} | Hold time, DIN valid after SCLK falling edge | 10 | | ns |
| t _{w(RSL)} | Pulse duration, SYNC/RESET low to generate device reset | 2048 | | t _{CLKIN} |
| t _{w(SYL)} | Pulse duration, SYNC/RESET low for synchronization | 1 | 2047 | t _{CLKIN} |
| t _{su(SY)} | Setup time, SYNC/RESET valid before CLKIN rising edge | 10 | | ns |

(1) $t_{CLKIN} = 1/f_{CLKIN}$

6.7 Switching Characteristics

over operating ambient temperature range, DOUT load: 20 pF || 100 kΩ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT ⁽¹⁾ |
|-----------------------|---|---|-------|-----|-----|---------------------|
| 1.65 V ≤ D | VDD ≤ 2.0 V | | 1 | | | |
| t _{p(CSDO)} | Propagation delay time, \overline{CS} falling edge to DOUT driven | | | | 50 | ns |
| t _{p(SCDO)} | Progapation delay time, SCLK rising edge to valid new DOUT | | | | 32 | ns |
| t _{p(CSDOZ)} | Propagation delay time, \overline{CS} rising edge to DOUT high impedace | | | | 75 | ns |
| t _{w(DRH)} | Pulse duration, DRDY high | | | 4 | | t _{CLKIN} |
| t _{w(DRL)} | Pulse duration, DRDY low | | | 4 | | t _{CLKIN} |
| | SPI timeout | | 32768 | | | t _{CLKIN} |
| t _{POR} | Power-on-reset time | Measured from supplies at 90% to first DRDY rising edge | | 250 | | μs |

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6.7 Switching Characteristics (continued)

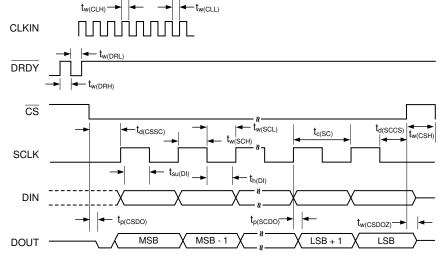
over operating ambient temperature range, DOUT load: 20 pF || 100 kΩ (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT ⁽¹⁾ |
|-----------------------|--|---|-------|-----|-----|---------------------|
| t _{REGACQ} | Register default acquisition time | | | 5 | | μs |
| 2.7 V ≤ DV | /DD ≤ 3.6 V | | | | 1 | |
| t _{p(CSDO)} | Propagation delay time, CS falling edge to DOUT driven | | | | 50 | ns |
| t _{p(SCDO)} | Progapation delay time, SCLK rising edge to valid new DOUT | | | | 20 | ns |
| t _{p(CSDOZ)} | Propagation delay time, CS rising edge to DOUT high impedace | | | | 75 | ns |
| t _{w(DRH)} | Pulse duration, DRDY high | | | 4 | | t _{CLKIN} |
| t _{w(DRL)} | Pulse duration, DRDY low | | | 4 | | t _{CLKIN} |
| | SPI timeout | | 32768 | | | t _{CLKIN} |
| t _{POR} | Power-on-reset time | Measured from supplies at 90% to first DRDY rising edge | | 250 | | μs |
| t _{REGACQ} | Register default acquisition time | | | 5 | | μs |

(1) $t_{CLKIN} = 1/f_{CLKIN}$

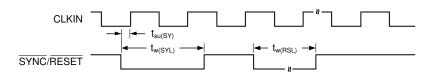


6.8 Timing Diagrams



NOTE: SPI settings are CPOL = 0 and CPHA = 1. \overline{CS} transitions must take place when SCLK is low.

🛛 6-1. SPI Timing Diagram



8 6-2. SYNC/RESET Timing Requirements

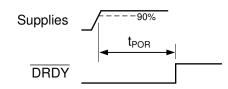
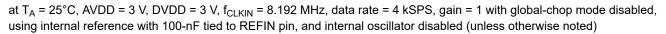
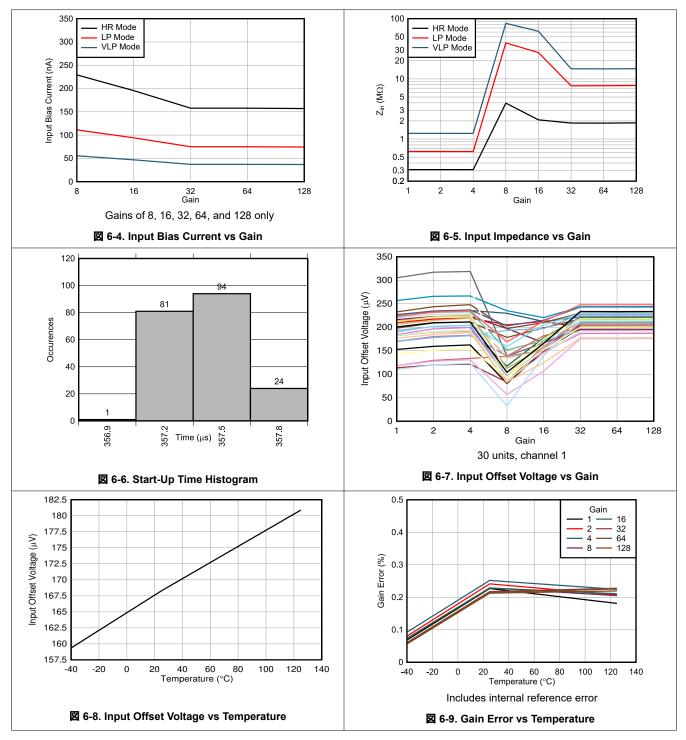


図 6-3. Power-On-Reset Timing



6.9 Typical Characteristics

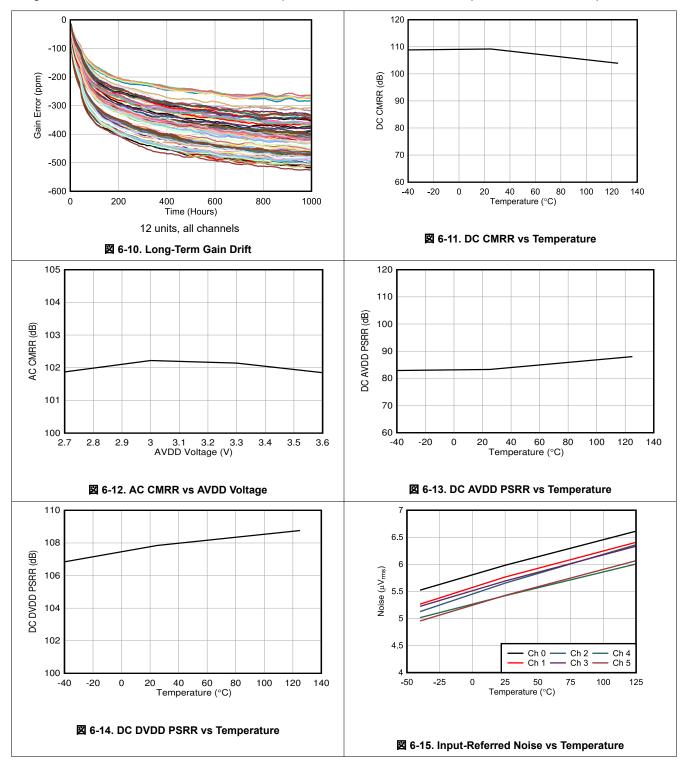






6.9 Typical Characteristics (continued)

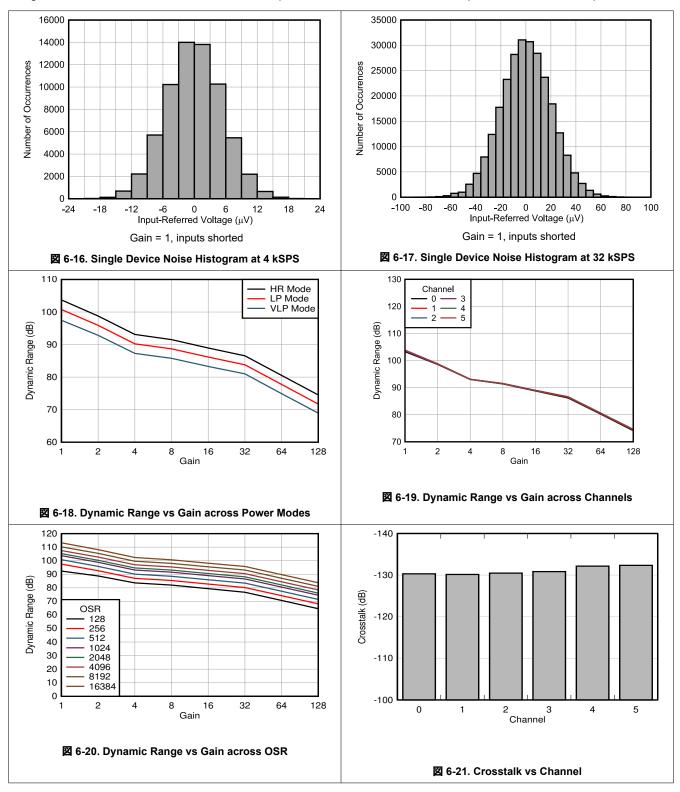
at $T_A = 25^{\circ}$ C, AVDD = 3 V, DVDD = 3 V, $f_{CLKIN} = 8.192$ MHz, data rate = 4 kSPS, gain = 1 with global-chop mode disabled, using internal reference with 100-nF tied to REFIN pin, and internal oscillator disabled (unless otherwise noted)





6.9 Typical Characteristics (continued)

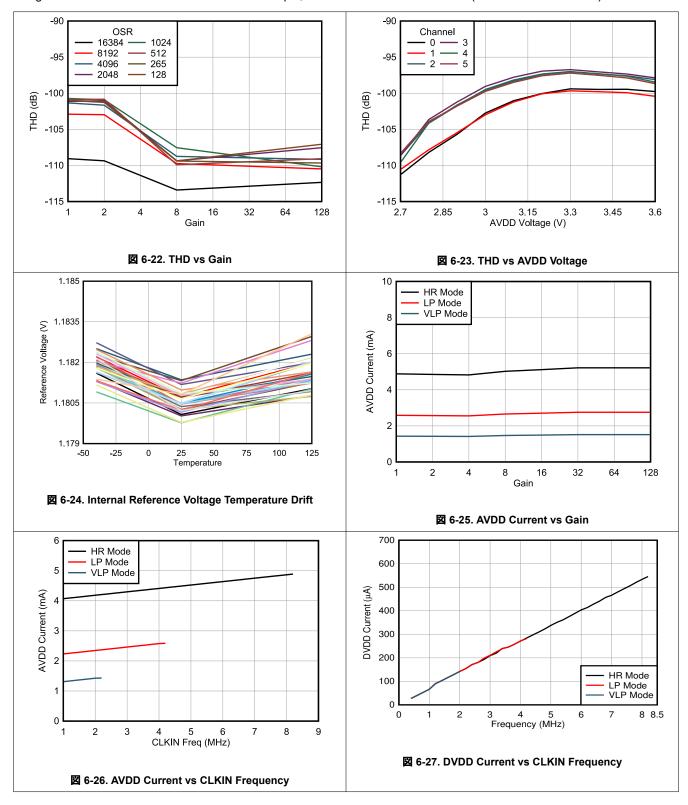
at $T_A = 25^{\circ}$ C, AVDD = 3 V, DVDD = 3 V, $f_{CLKIN} = 8.192$ MHz, data rate = 4 kSPS, gain = 1 with global-chop mode disabled, using internal reference with 100-nF tied to REFIN pin, and internal oscillator disabled (unless otherwise noted)





6.9 Typical Characteristics (continued)

at $T_A = 25^{\circ}$ C, AVDD = 3 V, DVDD = 3 V, $f_{CLKIN} = 8.192$ MHz, data rate = 4 kSPS, gain = 1 with global-chop mode disabled, using internal reference with 100-nF tied to REFIN pin, and internal oscillator disabled (unless otherwise noted)





(1)

(2)

7 Parameter Measurement Information

7.1 Noise Measurements

Adjust the data rate and gain to optimize the ADS131M06-Q1 noise performance. When averaging is increased by reducing the data rate, noise drops correspondingly. \cancel{R} 7-1 summarizes the ADS131M06-Q1 noise performance using the 1.2-V internal reference and a 3.0-V analog power supply. The data are representative of typical noise performance at T_A = 25°C when f_{CLKIN} = 8.192 MHz. The modulator clock frequency f_{MOD} is equal to f_{CLKIN} / 2. The data shown are typical input-referred noise results with the analog inputs shorted together and taking an average of multiple readings across all channels. A minimum 1 second of consecutive readings are used to calculate the RMS. \cancel{R} 7-2 shows the dynamic range and effective resolution calculated from the noise data. \cancel{R} 1 calculates dynamic range. \cancel{R} 2 calculates effective resolution. In each case, V_{REF} corresponds to the internal 1.2-V reference, or the voltage on the REFIN pin if the external reference is used. In global-chop mode, noise is improved by a factor of $\sqrt{2}$.

The noise performance scales with the OSR and gain settings, but is independent from the configured power mode. Thus, the device exhibits the same noise performance in different power modes when selecting the same OSR and gain settings. However, the data rate at the OSR settings scales based on the applied clock frequency for the different power modes.

Dynamic Range =
$$20 \times \log \left(\frac{V_{REF}}{\sqrt{2} \times Gain \times V_{RMS}} \right)$$

Effective Resolution =
$$log_2 \left(\frac{2 \times V_{REF}}{Gain \times V_{RMS}} \right)$$

| \mathbf{z} 7-1. Noise ($\mu \mathbf{v}_{RMS}$) at \mathbf{r}_{A} = 25 C | | | | | | | | | |
|---|--------------------------------|-------|-------|-------|------|------|------|------|------|
| OSR DATA RATE (kSPS), | | | GAIN | | | | | | |
| USK | f _{CLKIN} = 8.192 MHz | 1 | 2 | 4 | 8 | 16 | 32 | 64 | 128 |
| 16384 | 0.25 | 1.90 | 1.69 | 1.56 | 0.95 | 0.64 | 0.42 | 0.42 | 0.42 |
| 8192 | 0.5 | 2.39 | 2.13 | 2.13 | 1.29 | 0.86 | 0.57 | 0.57 | 0.57 |
| 4096 | 1 | 3.38 | 2.99 | 2.88 | 1.74 | 1.17 | 0.77 | 0.77 | 0.77 |
| 2048 | 2 | 4.25 | 3.91 | 3.79 | 2.27 | 1.52 | 1.00 | 1.00 | 1.00 |
| 1024 | 4 | 5.35 | 4.68 | 4.52 | 2.70 | 1.82 | 1.20 | 1.20 | 1.20 |
| 512 | 8 | 7.56 | 6.62 | 6.37 | 3.82 | 2.55 | 1.69 | 1.69 | 1.69 |
| 256 | 16 | 10.68 | 9.56 | 9.09 | 5.42 | 3.63 | 2.39 | 2.39 | 2.40 |
| 128 | 32 | 21.31 | 15.26 | 13.52 | 7.89 | 5.21 | 3.41 | 3.42 | 3.42 |

表 7-1. Noise (µV_{RMS}) at T_A = 25°C

| 表 7-2. Dynamic Range | e (Effective Resolution) at | T _A = 25°C |
|----------------------|-----------------------------|-----------------------|
|----------------------|-----------------------------|-----------------------|

| OSR | DATA RATE (kSPS), | GAIN | | | | | | | |
|-------|--------------------------------|------------|------------|------------|------------|-----------|-----------|-----------|-----------|
| OSIX | f _{CLKIN} = 8.192 MHz | 1 | 2 | 4 | 8 | 16 | 32 | 64 | 128 |
| 16384 | 0.25 | 113 (20.3) | 108 (19.4) | 103 (18.6) | 101 (18.3) | 98 (17.8) | 96 (17.5) | 90 (16.5) | 84 (15.4) |
| 8192 | 0.5 | 111 (19.9) | 106 (19.1) | 100 (18.1) | 98 (17.8) | 96 (17.4) | 93 (17.0) | 87 (16.0) | 81 (15.0) |
| 4096 | 1 | 108 (19.4) | 103 (18.6) | 97 (17.7) | 96 (17.4) | 93 (17.0) | 91 (16.6) | 85 (15.6) | 79 (14.6) |
| 2048 | 2 | 106 (19.1) | 101 (18.2) | 95 (17.3) | 93 (17.0) | 91 (16.6) | 88 (16.2) | 82 (15.2) | 76 (14.2) |
| 1024 | 4 | 104 (18.8) | 99 (18.0) | 93 (17.0) | 92 (16.8) | 89 (16.3) | 87 (15.9) | 81 (14.9) | 75 (13.9) |
| 512 | 8 | 101 (18.3) | 96 (17.5) | 90 (16.5) | 89 (16.3) | 86 (15.8) | 84 (15.4) | 78 (14.4) | 72 (13.4) |
| 256 | 16 | 98 (17.8) | 93 (16.9) | 87 (16.0) | 86 (15.8) | 83 (15.3) | 81 (14.9) | 75 (13.9) | 69 (12.9) |
| 128 | 32 | 92 (16.8) | 89 (16.3) | 84 (15.4) | 83 (15.2) | 80 (14.8) | 78 (14.4) | 72 (13.4) | 65 (12.4) |



8 Detailed Description

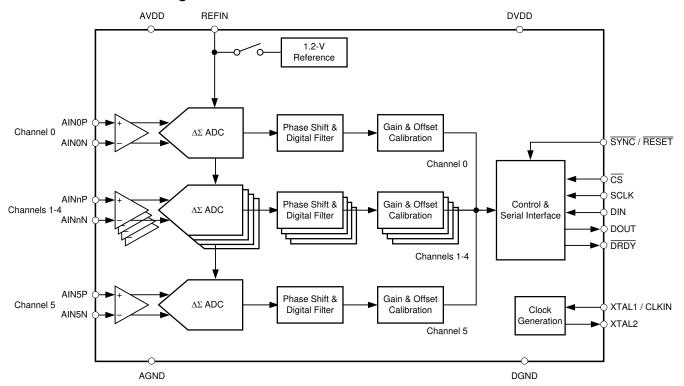
8.1 Overview

The ADS131M06-Q1 is a low-power, six-channel, simultaneous-sampling, 24-bit, delta-sigma ($\Delta\Sigma$) analog-todigital converter (ADC) with a low-drift internal reference voltage. The dynamic range, size, feature set, and power consumption are optimized for cost-sensitive applications requiring simultaneous-sampling.

The ADS131M06-Q1 requires both analog and digital supplies. The analog power supply (AVDD – AGND) can operate between 2.7 V and 3.6 V. An integrated negative charge pump allows absolute input voltages as low as 1.3 V below AGND, which enables measurements of input signals varying around ground with a single-ended power supply. The digital power supply (DVDD – DGND) accepts both 1.8-V and 3.3-V supplies. The device features a programmable gain amplifier (PGA) with gains up to 128. An integrated input precharge buffer enabled at gains greater than 4 ensures high input impedance at high PGA gain settings. The ADC receives the reference voltage from an integrated 1.2-V reference. The device allows differential input voltages as large as the reference. Three power-scaling modes allow designers to trade power consumption for ADC dynamic range.

Each channel on the ADS131M06-Q1 contains a digital decimation filter that demodulates the output of the $\Delta\Sigma$ modulators. The filter enables data rates as high as 32 kSPS per channel in high-resolution mode. The relative phase of the samples can be configured between channels, thus enabling an accurate compensation for the sensor phase response. Offset and gain calibration registers can be programmed to automatically adjust output samples for measured offset and gain errors. The *Functional Block Diagram* provides a detailed diagram of the ADS131M06-Q1.

The device communicates via a serial programming interface (SPI)-compatible interface. Several SPI commands and internal registers control the operation of the ADS131M06-Q1. Other devices can be added to the same SPI bus by adding discrete \overline{CS} control lines. The $\overline{SYNC}/\overline{RESET}$ pin can be used to synchronize conversions between multiple ADS131M06-Q1 devices as well as to maintain synchronization with external events.



8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Input ESD Protection Circuitry

Basic electrostatic discharge (ESD) circuitry protects the ADS131M06-Q1 inputs from ESD and overvoltage events in conjunction with external circuits and assemblies. 🛛 8-1 depicts a simplified representation of the ESD circuit. The protection for input voltages exceeding AVDD can be modeled as a simple diode.

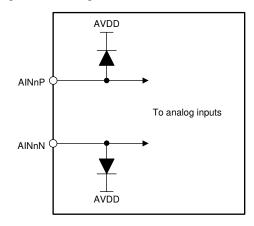


図 8-1. Input ESD Protection Circuitry

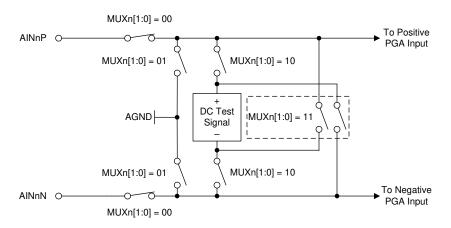
The ADS131M06-Q1 has an integrated negative charge pump that allows for input voltages below AGND with a unipolar supply. Consequently, shunt diodes between the inputs and AGND cannot be used to clamp excessive negative input voltages. Instead, the same diode that clamps overvoltage is used to clamp undervoltage at the reverse breakdown voltage. Take care to prevent input voltages or currents from exceeding the limits provided in the *Absolute Maximum Ratings* table.

8.3.2 Input Multiplexer

Each channel of the ADS131M06-Q1 has a dedicated input multiplexer. The multiplexer controls which signals are routed to the ADC channels. Configure the input multiplexer using the MUXn[1:0] bits in the CHn_CFG register. The input multiplexer allows the following inputs to be connected to the ADC channel:

- The analog input pins corresponding to the given channel
- AGND, which is helpful for offset calibration
- Positive DC test signal
- Negative DC test signal

See the *Internal Test Signals* section for more information about the test signals. 🛛 8-2 shows a diagram of the input multiplexer on the ADS131M06-Q1.



🛛 8-2. Input Multiplexer

8.3.3 Programmable Gain Amplifier (PGA)

Each channel of the ADS131M06-Q1 features an integrated programmable gain amplifier (PGA) that provides gains of 1, 2, 4, 8, 16, 32, 64, and 128. The gains for all channels are individually controlled by the PGAGAINn bits for each channel in the GAIN1 register.

Varying the PGA gain scales the differential full-scale input voltage range (FSR) of the ADC. 式 3 describes the relationship between FSR and gain. 式 3 uses the internal reference voltage, 1.2 V, as the scaling factor without accounting for gain error caused by tolerance in the reference voltage.

(3)

(4)

ota 8-1 shows the corresponding full-scale ranges for each gain setting, assuming the internal reference is used.

| 表 8-1. Full-Scale Range | | | | | |
|-------------------------|-----------|--|--|--|--|
| GAIN SETTING | FSR | | | | |
| 1 | ±1.2 V | | | | |
| 2 | ±600 mV | | | | |
| 4 | ±300 mV | | | | |
| 8 | ±150 mV | | | | |
| 16 | ±75 mV | | | | |
| 32 | ±37.5 mV | | | | |
| 64 | ±18.75 mV | | | | |
| 128 | ±9.375 mV | | | | |

± 0 4 E.... 0

The input impedance of the PGA dominates the input impedance characteristics of the ADS131M06-Q1. The PGA input impedance for gain settings up to 4 behaves according to \pm 4 without accounting for device tolerance and change over temperature. Minimize the output impedance of the circuit that drives the ADS131M06-Q1 inputs to obtain the best possible gain error, INL, and distortion performance.

330 kΩ × 4.096 MHz / f_{MOD}

where:

• f_{MOD} is the $\Delta\Sigma$ modulator frequency, f_{CLKIN} / 2

The device uses an input precharge buffer for PGA gain settings of 8 and higher. The input impedance at these gain settings is very high. Specifying the input bias current for these gain settings is therefore more useful. A plot of input bias current for the high gain settings is provided in \boxtimes 6-5.

8.3.4 Voltage Reference

The ADS131M06-Q1 has two reference voltage options: the internal reference and an external reference. The internal reference uses a low-drift, band-gap voltage to supply the reference for the ADC. The internal reference has a nominal voltage of 1.2 V, allowing the differential input voltage to swing from -1.2 V to 1.2 V. The reference circuitry starts up very quickly to accommodate the fast start-up feature of this device. The device waits until after the reference circuitry is fully settled before generating conversion data. Do not place any capacitance on the REFIN pin if the current-detect mode is used. See the Current-Detect Mode section for more details about the current-detect mode.

The device also allows for an external reference voltage, which can be input at the REFIN pin. The nominal external reference voltage is 1.25 V. The full-scale range of the ADC is 1.2 V / gain when the reference voltage is 1.25 V. The ADC full-scale range maintains the ratio of 1.2 to 1.25 for all recommended reference voltages. For example, the ADC full-scale range is 1.248 V / gain if 1.3 V is applied to the REFIN pin instead of the nominal 1.25 V. The start-up time for the external reference is governed by the external circuitry.

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8.3.5 Clocking and Power Modes

The master clock can either be sourced externally to the CLKIN pin or generated internally using the onboard oscillator that requires a crystal connected between the XTAL1/CLKIN and XTAL2 pins. For optimal performance, the modulator sampling clock must be synchronous with the serial data clock (SCLK). The modulator sampling clock is derived from the master clock, which means the master clock must be synchronous with SCLK. Therefore, for best performance, supply a master clock to CLKIN and make sure data retrieval is synchronous to the clock signal at CLKIN. When not in use, turn the internal oscillator off to save power.

The PWR[1:0] bits in the CLOCK register allow the device to be configured in one of three power modes: high-resolution (HR) mode, low-power (LP) mode, and very low-power (VLP) mode. Changing the PWR[1:0] bits scales the internal bias currents to achieve the expected power levels. The external clock frequency must follow the guidance provided in the *Recommended Operating Conditions* table corresponding to the intended power mode in order for the device to perform according to the specification.

8.3.6 ΔΣ Modulator

The ADS131M06-Q1 uses a delta-sigma ($\Delta\Sigma$) modulator to convert the analog input voltage to a one's density modulated digital bit-stream. The $\Delta\Sigma$ modulator oversamples the input voltage at a frequency many times greater than the output data rate. The modulator frequency, f_{MOD}, of the ADS131M06-Q1 is equal to half the controller clock frequency, that is, f_{MOD} = f_{CLKIN} / 2.

The output of the modulator is fed back to the modulator input through a digital-to-analog converter (DAC) as a means of error correction. This feedback mechanism shapes the modulator quantization noise in the frequency domain to make the noise more dense at higher frequencies and less dense in the band of interest. The digital decimation filter following the $\Delta\Sigma$ modulator significantly attenuates the out-of-band modulator quantization noise, allowing the device to provide excellent dynamic range.

8.3.7 Digital Filter

The $\Delta\Sigma$ modulator bitstream feeds into a digital filter. The digital filter is a linear phase, finite impulse response (FIR), low-pass sinc-type filter that attenuates the out-of-band quantization noise of the $\Delta\Sigma$ modulator. The digital filter demodulates the output of the $\Delta\Sigma$ modulator by averaging. The data passing through the filter is decimated and downsampled, to reduce the rate at which data come out of the modulator (f_{MOD}) to the output data rate (f_{DATA}). The decimation factor is defined as per \vec{t} 5 and is called the *oversampling ratio* (*OSR*).

(5)

The OSR is configurable and set by the OSR[2:0] bits in the CLOCK register. There are OSR settings in the ADS131M06-Q1, allowing different data rate settings for any given controller clock frequency. 表 8-2 lists the OSR settings and their corresponding output data rates for the nominal CLKIN frequencies mentioned.

The OSR determines the amount of averaging of the modulator output in the digital filter and therefore also the filter bandwidth. The filter bandwidth directly affects the noise performance of the ADC because lower bandwidth results in lower noise whereas higher bandwidth results in higher noise. See $\frac{1}{2}$ 7-1 for the noise specifications for various OSR settings.

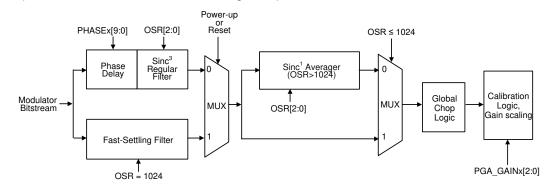


| POWER MODE | NOMINAL CONTROLLER CLOCK FREQUENCY | f _{MOD} | OSR | OUTPUT DATA RATE |
|------------|---------------------------------------|------------------|-------|------------------|
| | | | 128 | 32 kSPS |
| | | | 256 | 16 kSPS |
| | | | 512 | 8 kSPS |
| | 0.400 MUL | 4.000 MIL | 1024 | 4 kSPS |
| HR | 8.192 MHz | 4.096 MHz | 2048 | 2 kSPS |
| | | | 4096 | 1 kSPS |
| | | | 8192 | 500 SPS |
| | | | 16384 | 250 SPS |
| | 4.096 MHz | 2.048 MHz | 128 | 16 kSPS |
| | | | 256 | 8 kSPS |
| | | | 512 | 4 kSPS |
| | | | 1024 | 2 kSPS |
| LP | | | 2048 | 1 kSPS |
| | | | 4096 | 500 SPS |
| | | | 8192 | 250 SPS |
| | | | 16384 | 125 SPS |
| | | | 128 | 8 kSPS |
| | | | 256 | 4 kSPS |
| | | | 512 | 2 kSPS |
| | 2.048 MHz | 1.024 MHz | 1024 | 1 kSPS |
| VLP | 2.048 MHZ | 1.024 MHZ | 2048 | 500 SPS |
| | | | 4096 | 250 SPS |
| | | | 8192 | 125 SPS |
| | | | 16384 | 62.5 SPS |

表 8-2. OSR Settings and Data Rates for Nominal Controller Clock Frequencies

8.3.7.1 Digital Filter Implementation

 \boxtimes 8-3 shows the digital filter implementation of the ADS131M06-Q1. The modulator bit-stream feeds two parallel filter paths, a sinc³ filter, and a fast-settling filter path.





8.3.7.1.1 Fast-Settling Filter

At power-up or after a device reset, the ADS131M06-Q1 selects the fast-settling filter to allow for settled output data generation with minimal latency. The fast-settling filter has the characteristic of a first-order sinc filter (sinc¹). After two conversions, the device switches to and remains in the sinc³ filter path until the next time the device is reset or powered cycled.



The fast-settling filter exhibits wider bandwidth and less stop-band attenuation than the sinc³ filter. Consequently, the noise performance when using the fast-settling filter is not as high as with the sinc³ filter. The first two samples available from the ADS131M06-Q1 after a supply ramp or reset have the noise performance and frequency response corresponding to the fast-settling filter as specified in the *Electrical Characteristics* table in the *Specifications* section, whereas subsequent samples have the noise performance and frequency response consistent with the sinc³ filter. See the *Fast Start-Up Behavior* section for more details regarding the fast start-up capabilities of the ADS131M06-Q1.

8.3.7.1.2 SINC³ and SINC³ + SINC¹ Filter

The ADS131M06-Q1 selects the sinc³ filter path two conversion after power-up or device reset. For OSR settings of 128 to 1024 the sinc³ filter output directly feeds into the global-chop and calibration logic. For OSR settings of 2048 and higher the sinc³ filter is followed by a sinc¹ filter. As shown in $\frac{1}{8}$ 8-3, the sinc³ filter operates at a fixed OSR of 1024 in this case while the sinc¹ filter implements the additional OSRs of 2 to 16. That means when an OSR of 4096 (for example) is selected, the sinc³ filter operates at an OSR of 1024 and the sinc¹ filter at an OSR of 4.

The filter has infinite attenuation at integer multiples of the data rate except for integer multiples of f_{MOD} . Like all digital filters, the digital filter response of the ADS131M06-Q1 repeats at integer multiples of the modulator frequency, f_{MOD} . The data rate and filter notch frequencies scale with f_{MOD} .

When possible, plan frequencies for unrelated periodic processes in the application for integer multiples of the data rate such that any parasitic effect they have on data acquisition is effectively canceled by the notches of the digital filter. Avoid frequencies near integer multiples of f_{MOD} whenever possible because tones in these bands can alias to the band of interest.

The sinc³ and sinc³ + sinc¹ filters for a given channel require time to settle after a channel is enabled, the channel multiplexer or gain setting is changed, or a resynchronization event occurs. See the *Synchronization* section for more details on resynchronization. \pm 8-3 lists the settling times of the sinc³ and sinc³ + sinc¹ filters for each OSR setting. The ADS131M06-Q1 does not gate unsettled data. Therefore, the host must account for the filter settling time and disregard unsettled data if any are read. The data at the next DRDY falling edge after the filter settling time listed in \pm 8-3 has expired can be considered fully settled.

| OSR (SINC ³) 128 | OSR (SINC ¹) | SETTLING TIME (t _{CLKIN}) |
|---------------------------------|------------------------------|---|
| 128 | NI/A | |
| | IN/A | 856 |
| 256 | N/A | 1112 |
| 512 | N/A | 1624 |
| 1024 | N/A | 2648 |
| 1024 | 2 | 4696 |
| 1024 | 4 | 8792 |
| 1024 | 8 | 16984 |
| 1024 | 16 | 33368 |
| | 1024 1024 1024 1024 | 1024 N/A 1024 2 1024 4 1024 8 |

表 8-3. Digital Filter Start-Up Times After Power-Up or Resynchronization

8.3.7.2 Digital Filter Characteristic

 \pm 6 calculates the z-domain transfer function of a sinc³ filter that is used for OSRs of 1024 and lower.

$$|H(z)| = \left|\frac{1 - Z^{-N}}{N(1 - Z^{-1})}\right|^{3}$$

where N is the OSR.

(6)



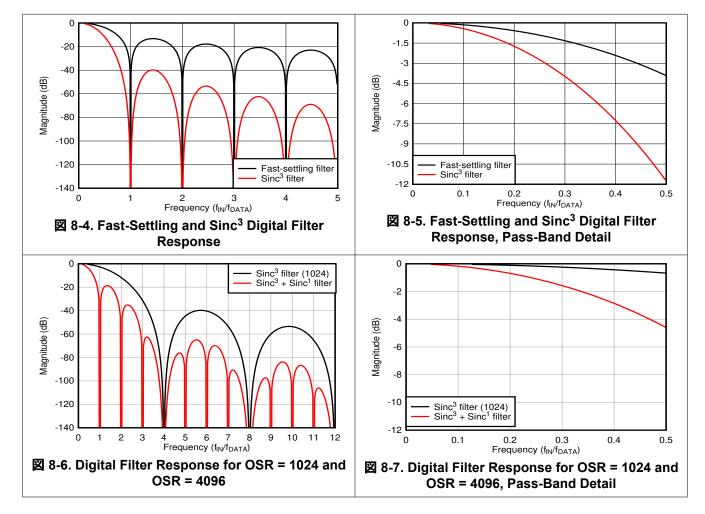
 \pm 7 calculates the transfer function of a sinc³ filter in terms of the continuous-time frequency parameter *f*.

$$H(f) \mid = \left| \frac{\sin \left(\frac{N \pi f}{f_{MOD}} \right)}{N \times \sin \left(\frac{\pi f}{f_{MOD}} \right)} \right|^{3}$$

(7)

where N is the OSR.

 \boxtimes 8-4 and \boxtimes 8-5 show the digital filter response of the fast-settling filter and the sinc³ filter for OSRs of 1024 and lower. \boxtimes 8-6 and \boxtimes 8-7 show the digital filter response of the sinc³ + sinc¹ filter for an OSR of 4096.





8.3.8 DC Block Filter

The ADS131M06-Q1 includes an optional high-pass filter to eliminate any systematic offset or low-frequency noise. The filter is enabled by writing any value in the DCBLOCK[3:0] bits in the CD_TH_LSB register besides 0h. The DC block filter can be enabled and disabled on a channel-by-channel basis by the DCBLKn_DIS bit in the CHn_CFG register for each respective channel.

 \boxtimes 8-8 shows the topology of the DC block filter. Coefficient *a* represents a register configurable value that configures the cutoff frequency of the filter. The cutoff frequency is configured using the DCBLOCK[3:0] bits in the CD_TH_LSB register. 表 8-4 describes the characteristics of the filter for various DCBLOCK[3:0] settings. The data provided in 表 8-4 is provided for an 8.192-MHz CLKIN frequency and a 4-kSPS data rate. The frequency response of the filter response scales directly with the frequency of CLKIN and the data rate.

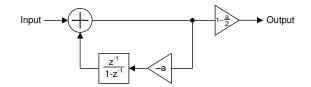


図 8-8. DC Block Filter Topology

| | | –3-dB | PASS-BAND A | TTENUATION ⁽¹⁾ | SETTLING TI | ME (Samples) | | | |
|--------------|---------------|--------------------------|-------------|---------------------------|--------------|---------------|--|--|--|
| DODLOCK[3.0] | a COEFFICIENT | CORNER ⁽¹⁾ | 50 Hz | 60 Hz | SETTLED >99% | FULLY SETTLED | | | |
| 0h | | DC block filter disabled | | | | | | | |
| 1h | 1/4 | 181 Hz | 11.5 dB | 10.1 dB | 17 | 88 | | | |
| 2h | 1/8 | 84.8 Hz | 5.89 dB | 4.77 dB | 36 | 187 | | | |
| 3h | 1/16 | 41.1 Hz | 2.24 dB | 1.67 dB | 72 | 387 | | | |
| 4h | 1/32 | 20.2 Hz | 657 mdB | 466 mdB | 146 | 786 | | | |
| 5h | 1/64 | 10.0 Hz | 171 mdB | 119 mdB | 293 | 1585 | | | |
| 6h | 1/128 | 4.99 Hz | 43.1 mdB | 29.9 mdB | 588 | 3182 | | | |
| 7h | 1/256 | 2.49 Hz | 10.8 mdB | 7.47 mdB | 1178 | 6376 | | | |
| 8h | 1/512 | 1.24 Hz | 2.69 mdB | 1.87 mdB | 2357 | 12764 | | | |
| 9h | 1/1024 | 622 mHz | 671 µdB | 466 µdB | 4714 | 25540 | | | |
| Ah | 1/2048 | 311 mHz | 168 µdB | 116 µdB | 9430 | 51093 | | | |
| Bh | 1/4096 | 155 mHz | 41.9 µdB | 29.1 µdB | 18861 | 102202 | | | |
| Ch | 1/8192 | 77.7 mHz | 10.5 µdB | 7.27 µdB | 37724 | 204447 | | | |
| Dh | 1/16384 | 38.9 mHz | 2.63 µdB | 1.82 µdB | 75450 | 409156 | | | |
| Eh | 1/32768 | 19.4 mHz | 655 ndB | 455 ndB | 150901 | 820188 | | | |
| Fh | 1/65536 | 9.70 mHz | 164 ndB | 114 ndB | 301803 | 1627730 | | | |

表 8-4. DC Block Filter Characteristics

(1) Values given are for a 4-kSPS data rate with a 8.192-MHz CLKIN frequency.

8.3.9 Internal Test Signals

The ADS131M06-Q1 features an internal analog test signal that is useful for troubleshooting and diagnosis. A positive or negative DC test signal can be applied to the channel inputs through the input multiplexer. The multiplexer is controlled through the MUXn[1:0] bits in the CHn_CFG register. The test signals are created by internally dividing the internal reference voltage. The same signal is shared by all channels.

The test signal is nominally 2 / 15 × V_{REF} . The test signal automatically adjusts the voltage level with the gain setting such that the ADC always measures a signal that is 2 / 15 × $V_{Diff Max}$. For example, at a gain of 1, this voltage equates to 160 mV. At a gain of 2, this voltage is 80 mV.

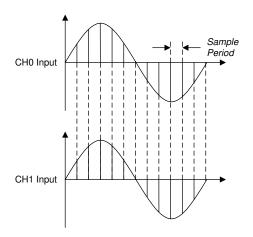


8.3.10 Channel Phase Calibration

The ADS131M06-Q1 allows fine adjustment of the sample phase between channels through the use of channel phase calibration. This feature is helpful when different channels are measuring the outputs of different types of sensors that have different phase responses. For example, in power metrology applications, voltage can be measured by a voltage divider, whereas current is measured using a current transformer that exhibits a phase difference between the input and output signals. The differences in phase between the voltage and current measurement must be compensated to measure the power and related parameters accurately.

The phase setting of the different channels is configured by the PHASEn[9:0] bits in the CHn_CFG register corresponding to the channel whose phase adjustment is desired. The register value is a 10-bit two's complement value corresponding to the number of modulator clock cycles of phase offset compared to a reference phase of 0 degrees.

The mechanism for achieving phase adjustment derives from the $\Delta\Sigma$ architecture. The $\Delta\Sigma$ modulator produces samples continuously at the modulator frequency, f_{MOD} . These samples are filtered and decimated to the output data rate by the digital filter. The ratio between f_{MOD} and the data rate is the oversampling ratio (OSR). Each conversion result corresponds to an OSR number of modulator samples provided to the digital filter. When the different channels of the ADS131M06-Q1 have no programmed phase offset between them, the modulator clock cycles corresponding to the conversion results of the different channels are aligned in the time domain. \boxtimes 8-9 depicts an example scenario where the voltage input to channel 1 has no phase offset from channel 0.



28 8-9. Two Channel Outputs With Equal Phase Settings

However, the sample period of one channel can be shifted with respect to another. If the inputs to both channels are sinusoids of the same frequency and the samples for these channels are retrieved by the host at the same time, the effect is that the phase of the channel with the modified sample period appears *shifted*. \boxtimes 8-10 depicts how the period corresponding to the samples are shifted between channels. \boxtimes 8-11 illustrates how the samples appear as having generated a phase shift when they are retrieved by the host.



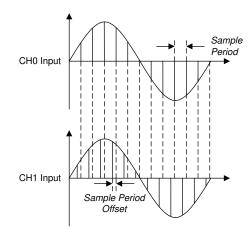
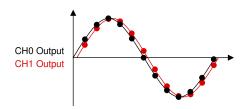


図 8-10. Channel 1 With a Positive Sample Phase Shift With Respect to Channel 0



2 8-11. Channels 1 and 0 From the Perspective of the Host

The valid setting range is from -OSR / 2 to (OSR / 2) - 1, except for OSRs greater than 1024, where the phase calibration setting is limited to -512 to 511. If a value outside of -OSR / 2 and (OSR / 2) - 1 is programmed, the device internally clips the value to the nearest limit. For example, if the OSR setting is programmed to 128 and the PHASEn[9:0] bits are programmed to 0001100100b corresponding to 100 modulator clock cycles, the device sets the phase of the channel to 63 because that value is the upper limit of phase calibration for that OSR setting. $\frac{1}{5}$ 8-5 gives the range of phase calibration settings for various OSR settings.

| a 6-5. Phase Calibration Setting Limits for Different USR Settings | | | | | | |
|--|--|--------------------------------|--|--|--|--|
| OSR SETTING | PHASE OFFSET RANGE (t _{MOD}) | PHASEn[9:0] BITS RANGE | | | | |
| 128 | –64 to 63 | 11 1100 0000b to 00 0011 1111b | | | | |
| 256 | -128 to 127 | 11 1000 0000b to 00 0111 1111b | | | | |
| 512 | -256 to 255 | 11 0000 0000b to 00 1111 1111b | | | | |
| 1024 | -512 to 511 | 10 0000 0000b to 01 1111 1111b | | | | |
| 2048 | -512 to 511 | 10 0000 0000b to 01 1111 1111b | | | | |
| 4096 | -512 to 511 | 10 0000 0000b to 01 1111 1111b | | | | |
| 8192 | -512 to 511 | 10 0000 0000b to 01 1111 1111b | | | | |
| 16384 | -512 to 511 | 10 0000 0000b to 01 1111 1111b | | | | |

| 表 8-5. Phase Calibration Settir | g Limits for Different OSR Settings |
|---------------------------------|-------------------------------------|
| | |

Follow these steps to create a phase shift larger than half the sample period for OSRs less than 2048:

- Create a phase shift corresponding to an integer number of sample periods by modifying the indices between channel data in software
- Use the phase calibration function of the ADS131M06-Q1 to create the remaining fractional sample period phase shift

For example, to create a phase shift of 2.25 samples between channels 0 and 1, create a phase shift of two samples by aligning sample N in the channel 0 output data stream with sample N+2 in the channel 1 output data



stream in the host software. Make the remaining 0.25 sample adjustment using the ADS131M06-Q1 phase calibration function.

The phase calibration settings of the channels affect the timing of the data-ready interrupt signal, DRDY. See the *Data Ready (DRDY)* section for more details regarding how phase calibration affects the DRDY signal.

8.3.11 Calibration Registers

The calibration registers allow for the automatic computation of calibrated ADC conversion results from preprogrammed values. The host can rely on the device to automatically correct for system gain and offset after the error correction terms are programmed into the corresponding device registers. The measured calibration coefficients must be store in external non-volatile memory and programmed into the registers each time the ADS131M06-Q1 powers up because the ADS131M06-Q1 registers are volatile.

The offset calibration registers are used to correct for system offset error, otherwise known as *zero error*. Offset error corresponds to the ADC output when the input to the system is zero. The ADS131M06-Q1 corrects for offset errors by subtracting the contents of the OCALn[23:0] register bits in the CHn_OCAL_MSB and CHn_OCAL_LSB registers from the conversion result for that channel before being output. There are separate CHn_OCAL_MSB and CHnOCAL_LSB registers for each channel, which allows separate offset calibration coefficients to be programmed for each channel. The contents of the OCALn[23:0] bits are interpreted by the device as 24-bit two's complement values, which is the same format as the ADC data.

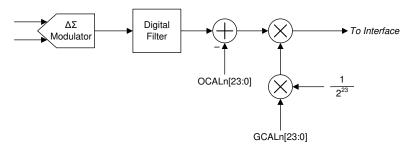
The gain calibration registers are used to correct for system gain error. Gain error corresponds to the deviation of gain of the system from the ideal value. The ADS131M06-Q1 corrects for gain errors by multiplying the ADC conversion result by the value given by the contents of the GCALn[23:0] register bits in the CHn_GCAL_MSB and CHn_GCAL_LSB registers before being output. There are separate CHn_GCAL_MSB and CHn_GCAL_LSB registers for each channel, which allows separate gain calibration coefficients to be programmed for each channel. The contents of the GCALn[23:0] bits are interpreted by the device as 24-bit unsigned values corresponding to linear steps ranging from gains of 0 to $2 - (1 / 2^{23})$. $\gtrsim 8-6$ describes the relationship between the GCALn[23:0] bit values and the gain calibration factor.

| GCALn[23:0] VALUE | GAIN CALIBRATION FACTOR | | | | |
|-------------------|-----------------------------|--|--|--|--|
| 000000h | 0 | | | | |
| 000001h | 1.19 × 10 ^{−7} | | | | |
| 800000h | 1 | | | | |
| FFFFEh | 2 – 2.38 × 10 ⁻⁷ | | | | |
| FFFFFh | 2 – 1.19 × 10 ⁻⁷ | | | | |

表 8-6. GCALn[23:0] Bit Mapping

The calibration registers do not need to be enabled because they are always in use. The OCALn[23:0] bits have a default value of 000000h resulting in no offset correction. Similarly, the GCALn[23:0] bits default to 800000h resulting in a gain calibration factor of 1.

図 8-12 depicts a block diagram illustrating the mechanics of the calibration registers on one channel of the ADS131M06-Q1.







8.3.12 Communication Cyclic Redundancy Check (CRC)

The ADS131M06-Q1 features a cyclic redundancy check (CRC) engine on both input and output data to mitigate SPI communication errors. The CRC word is 16 bits wide for either input or output CRC. Coverage includes all words in the SPI frame where the CRC is enabled, including padded bits in a 32-bit word size.

CRC on the SPI input is optional and can be enabled and disabled by writing the RX CRC EN bit in the MODE register. Input CRC is disabled by default. When the input CRC is enabled, the device checks the provided input CRC against the CRC generated based on the input data. A CRC error occurs if the CRC words do not match. The device does not execute any commands, except for the WREG command, if the input CRC check fails. A WREG command always executes even when the CRC check fails. The device sets the CRC ERR bit in the STATUS register for all cases of a CRC error. The response on the output in the SPI frame following the frame where the CRC error occurred is that of a NULL command, which means the STATUS register plus the conversion data are output in the following SPI frame. The CRC ERR bit is cleared when the STATUS register is output.

The output CRC cannot be disabled and always appears at the end of the output frame. The host can ignore the data if the output CRC is not used.

There are two types of CRC polynomials available: CCITT CRC and ANSI CRC (CRC-16). The CRC setting determines the algorithm for both the input and output CRC. The CRC type is programmed by the CRC_TYPE bit in the MODE register. $\frac{1}{5}$ 8-7 lists the details of the two CRC types.

The seed value of the CRC calculation is FFFFh.

| 表 8-7. CRC Types | | | | |
|------------------|-----------------------------|---------------------|--|--|
| CRC TYPE | POLYNOMIAL | BINARY POLYNOMIAL | | |
| CCITT CRC | $x^{16} + x^{12} + x^5 + 1$ | 0001 0000 0010 0001 | | |
| ANSI CRC | $x^{16} + x^{15} + x^2 + 1$ | 1000 0000 0000 0101 | | |

8.3.13 Register Map CRC

The ADS131M06-Q1 performs a CRC on the register map as a means to check for unintended changes to the registers. Enable the register map CRC by setting the REG CRC EN bit in the MODE register. When enabled, the device constantly calculates the register map CRC using each bit in the writable register space. The register addresses covered by the register map CRC on the ADS131M06-Q1 are 02h through 26h. The CRC is calculated beginning with the MSB of register 02h and ending with the LSB of register 26h using the polynomial selected in the CRC TYPE bit in the MODE register.

The CRC calculation is initialized with the seed value of FFFFh.

The calculated CRC is a 16-bit value and is stored in the REGMAP CRC register. The calculation is done using one register map bit per CLKIN period and constantly checks the result against the previous calculation. The REG MAP bit in the STATUS register is set to flag the host if the register map CRC changes, including changes resulting from register writes. The bit is cleared by reading the STATUS register, or by the STATUS register being output as a response to the NULL command.



8.4 Device Functional Modes

⊠ 8-13 shows a state diagram depicting the major functional modes of the ADS131M06-Q1 and the transitions between them.

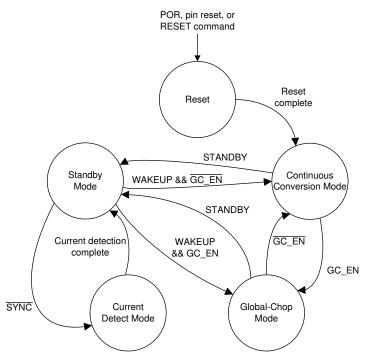


図 8-13. State Diagram Depicting Device Functional Modes

8.4.1 Power-Up and Reset

The ADS131M06-Q1 is reset in one of three ways: by a power-on reset (POR), by the <u>SYNC/RESET</u> pin, or by a RESET command. After a reset occurs, the configuration registers are reset to the default values and the device begins generating conversion data as soon as a valid MCLK is provided. In all three cases a low to high transition on the <u>DRDY</u> pin indicates that the SPI interface is ready for communication. The device ignores any SPI communication before this point.

8.4.1.1 Power-On Reset

Power-on reset (POR) is the reset that occurs when a valid supply voltage is first applied. The POR process requires t_{POR} from when the supply voltages reach 90% of their nominal value. Internal circuitry powers up and the registers are set to their default state during this time. The DRDY pin transitions from low to high immediately after t_{POR} indicating the SPI interface is ready for communication. The device ignores any SPI communication before this point.

8.4.1.2 SYNC/RESET Pin

The $\overline{SYNC/RESET}$ pin is an active low, dual-function pin that generates a reset if the pin is held low longer than $t_{w(RSL)}$. The device maintains a reset state until $\overline{SYNC/RESET}$ is returned high. The host must wait for at least t_{REGACQ} after $\overline{SYNC/RESET}$ is brought high or for the \overline{DRDY} rising edge before communicating with the device. Conversion data are generated immediately after the registers are reset to their default values, as described in the *Fast Start-Up Behavior* section.

8.4.1.3 RESET Command

The ADS131M06-Q1 can be reset via the SPI RESET command (0011h). The device communicates in frames of a fixed length. See the *SPI Communication Frames* section for details regarding SPI data framing on the ADS131M06-Q1. The RESET command occurs in the first word of the data frame, but the command is not latched by the device until the entire frame is complete. After the response completes channel data and CRC



words are clocked out. Terminating the frame early causes the RESET command to be ignored. Eight words are required to complete a frame on the ADS131M06-Q1.

A reset occurs immediately after the command is latched. The host must wait for t_{REGACQ} before communicating with the device to ensure the registers have assumed their default settings. Conversion data are generated immediately after the registers are reset to their default values, as described in the *Fast Start-Up Behavior* section.

8.4.2 Fast Start-Up Behavior

The ADS131M06-Q1 begins generating conversion data shortly after startup as soon as a valid CLKIN signal is provided to the $\Delta\Sigma$ modulators. The fast start-up feature is useful for applications such as circuit breakers powered from the mains that require a fast determination of the input voltage soon after power is applied to the device. Fast start up is accomplished via two mechanisms. First, the device internal power-supply circuitry is designed specifically to enable fast start up. Second, the digital decimation filter dynamically switches from a fast-settling filter to a sinc³ filter when the sinc³ filter has had time to settle.

After the supplies are ramped to 90% of their final values, the device requires t_{POR} for the internal circuitry to settle. The end of t_{POR} is indicated by a transition of \overline{DRDY} from low to high. The transition of \overline{DRDY} from low to high also indicates the SPI interface is ready to accept commands.

The $\Delta\Sigma$ modulators of the ADS131M06-Q1 require CLKIN to toggle after t_{POR} to begin working. The modulators begin sampling the input signal after an initial wait time delay of (256 + 44) × t_{MOD} when CLKIN begins toggling. Therefore, provide a valid clock signal on CLKIN as soon as possible after the supply ramp to achieve the fastest possible startup time.

The data generated by the $\Delta\Sigma$ modulators are fed to the digital filter blocks. The data are provided to both the fast-settling filter and the sinc³ filter paths. The fast-settling filter requires only one data rate period to provide settled data. Meanwhile, the sinc³ filter requires three data rate periods to settle. The fast-settling filter generates the output data for the two interim ADC output samples indicated by DRDY transitioning from high to low while the sinc³ filter is settling. The device disables the fast-settling filter and provides conversion data from the sinc³ filter path for the third and following samples. \boxtimes 8-14 shows the behavior of the fast start-up feature when using an external clock that is provided to the device right after the supplies have ramped. $\frac{1}{2}$ 8-8 shows the values for the various start-up and settling times relevant to the device start up.

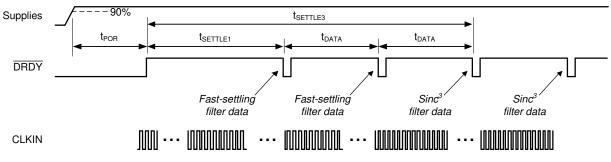


図 8-14. Fast Startup Behavior and Settling Times

| PARAMETER | VALUE (DETAILS) (t _{MOD}) | VALUE (t _{MOD}) | VALUE AT f _{CLKIN} = 8.192 MHz (ms) |
|-------------------------|--|------------------------------|---|
| $t_{DATA} = 1/f_{DATA}$ | 1024 | 1024 | 0.250 |
| t _{SETTLE1} | 256 + 44 + 1024 | 1324 | 0.323 |
| t _{SETTLE3} | 256 + 44 + 3 x 1024 | 3372 | 0.823 |

| 表 8-8. Fast Startup Settling | g Times for Default OSR = 1024 |
|------------------------------|--------------------------------|
|------------------------------|--------------------------------|

The fast-settling filter provides conversion data that are significantly noisier than the data that comes from the sinc³ filter path, but allows the device to provide settled conversion data during the longer settling time of the more accurate sinc³ digital filter. If the level of precision provided by the fast-settling filter is insufficient even for



the first samples immediately following start up, ignore the first two instances of DRDY toggling from high to low and begin collecting data on the third instance.

The start-up process following a RESET command or a pin reset using the $\overline{SYNC}/\overline{RESET}$ pin is similar to what occurs after power up. However there is no t_{POR} in the case of a command or pin reset because the supplies are already ramped. After reset, the device waits for the initial wait time delay of (256 + 44) × t_{MOD} before providing modulator samples to the two digital filters. The fast-settling filter is enabled for the first two output samples.

8.4.3 Conversion Modes

There are two ADC conversion modes on the ADS131M06-Q1: continuous-conversion and global-chop mode. Continuous-conversion mode is a mode where ADC conversions are generated constantly by the ADC at a rate defined by f_{MOD} / OSR. Global-chop mode differs from continuous-conversion mode because global-chop periodically chops (or swaps) the inputs, which reduces system offset errors at the cost of settling time between the points when the inputs are swapped. In either continuous-conversion or global-chop mode, there are three power modes that provide flexible options to scale power consumption with bandwidth and dynamic range. The *Power Modes* section discusses these power modes in further detail.

8.4.3.1 Continuous-Conversion Mode

Continuous-conversion mode is the mode in which ADC data are generated constantly at the rate of f_{MOD} / OSR. New data are indicated by a DRDY falling edge at this rate. Continuous-conversion mode is intended for measuring AC signals because this mode allows for higher output data rates than global-chop mode.

8.4.3.2 Global-Chop Mode

The ADS131M06-Q1 incorporates a global-chop mode option to reduce offset error and offset drift inherent to the device resulting from mismatch in the internal circuitry to very low levels. When global-chop mode is enabled by setting the GC_EN bit in the GLOBAL_CHOP_CFG register, the device uses the conversion results from two consecutive internal conversions taken with opposite input polarity to cancel the device offset voltage. Conversion *n* is taken with normal input polarity. The device then reverses the internal input polarity for conversion n + 1. The average of two consecutive conversions (*n* and n + 1, n + 1 and n + 2 and so on) yields the final offset compensated result.

 \boxtimes 8-15 shows a block diagram of the global-chop mode implementation. The combined PGA and ADC internal offset voltage is modeled as V_{OFS}. Only this device inherent offset voltage is reduced by global-chop mode. Offset in the external circuitry connected to the analog inputs is not affected by global-chop mode.

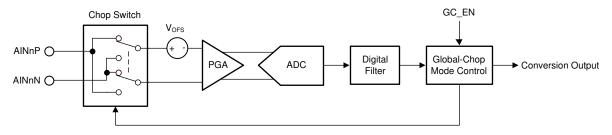
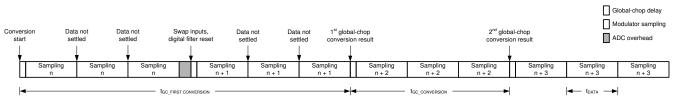


図 8-15. Global-Chop Mode Implementation

The conversion period in global-chop mode differs from the conversion time when global-chop mode is disabled ($t_{DATA} = OSR \times t_{MOD}$). 🖾 8-16 shows the conversion timing for an ADC channel using global-chop mode.







Every time the device swaps the input polarity, the digital filter is reset. The ADC then always takes three internal conversions to produce one settled global-chop conversion result.

The ADS131M06-Q1 provides a programmable delay (t_{GC_DLY}) between the end of the previous conversion period and the beginning of the subsequent conversion period after the input polarity is swapped. This delay allows external input circuitry to settle because the chopping switches interface directly with the analog inputs. The GC_DLY[3:0] bits in the GLOBAL_CHOP_CFG register configure the delay after chopping the inputs. The global-chop delay is selected in terms of modulator clock periods from 2 to 65,536 x t_{MOD}.

The effective conversion period in global-chop mode follows $\neq 8$. A $\overline{\text{DRDY}}$ falling edge is generated each time a new global-chop conversion becomes available to the host.

The conversion process of all ADC channels in global-chop mode is restarted in the following two conditions so that all channels start sampling at the same time:

- Falling edge of the <u>SYNC/RESET</u> pin
- Change of OSR setting

The conversion period of the first conversion after the ADC channels are reset is considerably longer than the conversion period of all subsequent conversions mentioned in $\neq 8$, because the device must first perform two fully settled internal conversions with the input polarity swapped. The conversion period for the first conversion in global-chop mode follows $\neq 9$.

$$t_{GC_CONVERSION} = t_{GC_DLY} + 3 \times OSR \times t_{MOD}$$
(8)

$$t_{GC_FIRST_CONVERSION} = t_{GC_DLY} + 3 \times OSR \times t_{MOD} + t_{GC_DLY} + 3 \times OSR \times t_{MOD} + 44 \times t_{MOD}$$
(9)

Using global-chop mode reduces the ADC noise shown in $\frac{1}{2}$ 7-1 at a given OSR by a factor of $\sqrt{2}$ because two consecutive internal conversions are averaged to yield one global-chop conversion result. The DC test signal cannot be measured in global-chop mode.

Phase calibration is automatically disabled in global-chop mode.

8.4.4 Power Modes

In both continuous-conversion and global-chop mode, there are three selectable power modes that allow scaling of power with bandwidth and performance: high-resolution (HR) mode, low-power (LP) mode, and very-low-power (VLP) mode. The mode is selected by the PWR[1:0] bits in the CLOCK register. See the *Recommended Operating Conditions* table for restrictions on the CLKIN frequency for each power mode.

8.4.5 Standby Mode

Standby mode is a low-power state in which all channels are disabled, and the reference and other nonessential circuitry are powered down. This mode differs from completely powering down the device because the device retains the register settings. Enter standby mode by sending the STANDBY command (0022h). Stop toggling CLKIN when the device is in standby mode to minimize device power consumption. Exit standby mode by sending the WAKEUP command (0033h). After exiting standby mode, the modulators begin sampling the input signal after a modulator settling time of 8 × t_{MOD} when CLKIN begins toggling.

8.4.6 Current-Detect Mode

Current-detect mode is a special mode that is helpful for applications requiring tamper detection when the equipment is in a low-power state. In this mode, the ADS131M06-Q1 collects a configurable number of samples at a nominal data rate of 2.7 kSPS and compares the absolute value of the results to a programmable threshold. If a configurable number of results exceed the threshold, the host is notified via a DRDY falling edge and the device returns to standby mode. Enter current-detect mode by providing a negative pulse on SYNC/RESET with a pulse duration less than $t_{w(RSL)}$ when in standby mode. Current-detect mode can only be entered from standby mode.

The device uses a limited power operating mode to generate conversions in current-detect mode. The conversion results are only used for comparison by the internal digital threshold comparator and are not accessible by the host. The device uses an internal oscillator that enables the device to capture the data without



the use of the external clock input. Do not toggle CLKIN when in current-detect mode to minimize device power consumption. Do not place a capacitor on the REFIN pin if current-detect mode is used. Capacitance on this pin requires time to start up, and the resulting ADC conversions generated during current-detect mode are not valid when the voltage on the REFIN pin is charging.

Current-detect mode is configured in the CFG, THRSHLD_MSB, and THRSHLD_LSB registers. Enable and disable current-detect mode by toggling the CD_EN bit in the CFG register. The THRSHLD_MSB and THRSHLD_LSB registers contain the CD_THRSH[23:0] bits that represent the digital comparator threshold value during current detection.

The number of samples used for current detection are programmed by the CD_LEN[2:0] bits in the CFG register. The number of samples used for current detection range from 128 to 3584.

The programmable values in CD_NUM[2:0] configure the number of samples that must exceed the threshold for a detection to occur. The purpose of requiring multiple samples for detection is to control noisy values that may exceed the threshold, but do not represent a high enough power level to warrant action by the host. In summary, the conversion result must exceed the value programmed in CD_THRSH[23:0] a number of times as represented by the value stored in CD_NUM[2:0].

The device can be configured to notify the host based on any of the results from individual channels, all channels, or any combination of channels. The CD_ALLCH bit in the CFG register determines how many channels are required to exceed the programmed thresholds to trigger a current detection. When the bit is 1, all enabled channels are required to meet the current detection requirements in order for the host to be notified. If the bit is 0, any enabled channel triggers a current detection notification if the requirements are met. Enable and disable channels using the CHn_EN bits in the CLK register to control which combination of channels must meet the requirements to trigger a current-detection notification.

☑ 8-17 illustrates a flow chart depicting the current-detection process on the ADS131M06-Q1.



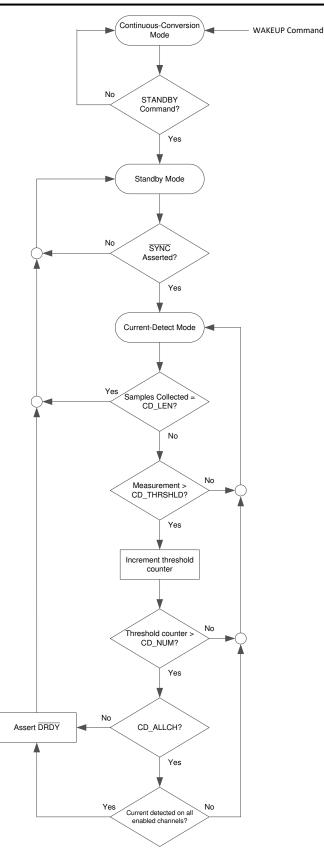


図 8-17. Current-Detect Mode Flow Chart



8.5 Programming

8.5.1 Interface

The ADS131M06-Q1 uses an SPI-compatible interface to configure the device and retrieve conversion data. The device always acts as an SPI peripheral; SCLK and \overline{CS} are inputs to the interface. The interface operates in SPI mode 1 where CPOL = 0 and CPHA = 1. In SPI mode 1, the SCLK idles low and data are launched or changed only on SCLK rising edges; data are latched or read by the controller and peripheral on SCLK falling edges. The interface is full-duplex, meaning data can be sent and received simultaneously by the interface. The device includes the typical SPI signals: SCLK, \overline{CS} , DIN (PICO), and DOUT (POCI). In addition, there are two other digital pins that provide additional functionality. The \overline{DRDY} pin serves as a flag to the host to indicate new conversion data are available. The SYNC/RESET pin is a dual-function pin that allows synchronization of conversions to an external event and allows for a hardware device reset.

8.5.1.1 Chip Select (CS)

The \overline{CS} pin is an active low input signal that selects the device for communication. The device ignores any communication and DOUT is high impedance when \overline{CS} is held high. Hold \overline{CS} low for the duration of a communication frame to ensure proper communication. The interface is reset each time \overline{CS} is taken high.

8.5.1.2 Serial Data Clock (SCLK)

The SCLK pin is an input that serves as the serial clock for the interface. Output data on the DOUT pin transition on the rising edge of SCLK and input data on DIN are latched on the falling edge of SCLK.

8.5.1.3 Serial Data Input (DIN)

The DIN pin is the serial data input pin for the device. Serial commands are shifted in through the DIN pin by the device with each SCLK falling edge when the \overline{CS} pin is low.

8.5.1.4 Serial Data Output (DOUT)

The DOUT pin is the serial data output pin for the device. The device shifts out command responses and ADC conversion data serially with each rising SCLK edge when the \overline{CS} pin is low. This pin assumes a high-impedance state when \overline{CS} is high.

8.5.1.5 Data Ready (DRDY)

The DRDY pin is an active low output that indicates when new conversion data are ready in conversion mode or that the requirements are met for current detection when in current-detect mode. Connect the DRDY pin to a digital input on the host to trigger periodic data retrieval in conversion mode.

The timing of DRDY with respect to the sampling of a given channel on the ADS131M06-Q1 depends on the phase calibration setting of the channel and the state of the DRDY_SEL[1:0] bits in the MODE register. Setting the DRDY_SEL[1:0] bits to 00b configures DRDY to assert when the channel with the largest positive phase calibration setting, or the most lagging, has a new conversion result. When the bits are 01b, the device asserts DRDY each time any channel data are ready. Finally, setting the bits to either 10b or 11b configures the device to assert DRDY when the channel with the most negative phase calibration setting, or the most leading, has new conversion data. Changing the DRDY_SEL[1:0] bits has no effect on DRDY behavior in global-chop mode because phase calibration is automatically disabled in global-chop mode.

The timing of the first \overline{DRDY} assertion after channels are enabled or after a synchronization pulse is provided depends on the phase calibration setting. If the channel that causes \overline{DRDY} to assert has a phase calibration setting less than zero, the first \overline{DRDY} assertion can be less than one sample period from the channel being enabled or the occurrence of the synchronization pulse. However, \overline{DRDY} asserts in the next sample period if the phase setting puts the output timing too close to the beginning of the sample period.

8-9 lists the phase calibration setting boundary at which \overline{DRDY} either first asserts within a sample period, or in the next sample period. If the setting for the channel configured to control \overline{DRDY} assertion is greater than the value listed in 8-9 for each OSR, \overline{DRDY} asserts for the first time within a sample period of the channel being enabled or the synchronization pulse. If the phase setting value is equal to or more negative than the value in



8-9, DRDY asserts in the following sample period. See the *Synchronization* section for more information about synchronization.

| A 0-9. Flase Setting First DRDT Assertion Boundary | | | | |
|--|------------------------|----------------------------------|--|--|
| OSR | PHASE SETTING BOUNDARY | PHASEn[9:0] BIT SETTING BOUNDARY | | |
| 128 | -19 | 3EDh | | |
| 256 | -83 | 3ADh | | |
| 512 | -211 | 32Dh | | |
| 1024 | -467 | 22Dh | | |
| >1024 | None | N/A | | |

表 8-9. Phase Setting First DRDY Assertion Boundary

The DRDY_HIZ bit in the MODE register configures the state of the \overline{DRDY} pin when deasserted. By default the bit is 0b, meaning the pin is actively driven high using a push-pull output stage. When the bit is 1b, \overline{DRDY} behaves like an open-drain digital output. Use a 100-k Ω pullup resistor to pull the pin high when \overline{DRDY} is not asserted.

The DRDY_FMT bit in the MODE register determines the format of the DRDY signal. When the bit is 0b, new data are indicated by DRDY changing from high to low and remaining low until either all of the conversion data are shifted out of the device, or remaining low and going high briefly before the next time DRDY transitions low. When the DRDY_FMT bit is 1b, new data are indicated by a short negative pulse on the DRDY pin. If the host does not read conversion data after the DRDY pulse when DRDY_FMT is 1b, the device skips a conversion result and does not provide another DRDY pulse until the second following instance when data are ready because of how the pulse is generated. See the *Collecting Data for the First Time or After a Pause in Data Collection* section for more information about the behavior of DRDY when data are not consistently read.

The DRDY pulse is blocked when new conversions complete while conversion data are read. Therefore, avoid reading ADC data during the time where new conversions complete in order to achieve consistent DRDY behavior.

8.5.1.6 Conversion Synchronization or System Reset (SYNC/RESET)

The <u>SYNC/RESET</u> pin is a multifunction digital input pin that serves primarily to allow the host to synchronize conversions to an external process or to reset the device. See the <u>Synchronization</u> section for more details regarding the synchronization function. See the <u>SYNC/RESET</u> Pin section for more details regarding how the device is reset.

8.5.1.7 SPI Communication Frames

SPI communication on the ADS131M06-Q1 is performed in frames. Each SPI communication frame consists of several words. The word size is configurable as either 16 bits, 24 bits, or 32 bits by programming the WLENGTH[1:0] bits in the MODE register.

The ADS131M06-Q1 implements a timeout feature for SPI communication. Enable or disable the timeout using the TIMEOUT bit in the MODE register. When enabled, the entire SPI frame (first SCLK to last SCLK) must complete within 2^{15} CLKIN cycles otherwise the SPI resets. This feature is provided as a means to recover SPI synchronization for cases where \overline{CS} is tied low.

The interface is full duplex, meaning that the interface is capable of transmitting data on DOUT while simultaneously receiving data on DIN. The input frame that the host sends on DIN always begins with a command. The first word on the output frame that the device transmits on DOUT always begins with the response to the command that was written on the previous input frame. The number of words in a command depends on the command provided. For most commands, there are eight words in a frame. On DIN, the host provides the command, the command CRC if input CRC is enabled or a word of zeros if input CRC is disabled, and six additional words of zeros. Simultaneously on DOUT, the device outputs the response from the previous frame command, six words of ADC data representing the six ADC channels, and a CRC word. 🛛 8-18 illustrates a typical command frame structure.



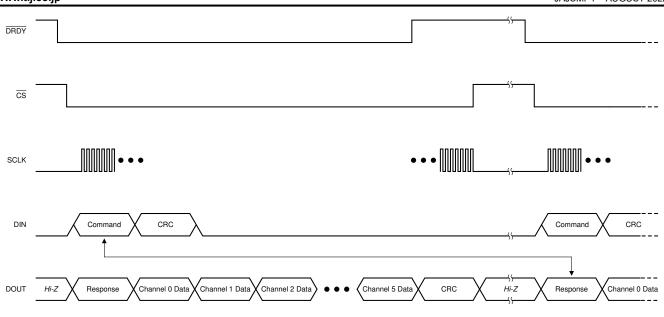


図 8-18. Typical Communication Frame

There are some commands that require more than eight words. In the case of a read register (RREG) command where more than a single register is read, the response to the command contains the acknowledgment of the command followed by the register contents requested, which may require a larger frame depending on how many registers are read. See the *RREG (101a aaaa annn nnnn)* section for more details on the RREG command.

In the case of a write register (WREG) command where more than a single register is written, the frame extends to accommodate the additional data. See the *WREG (011a aaaa annn nnnn)* section for more details on the WREG command.

See the *Commands* section for a list of all valid commands and their corresponding responses on the ADS131M06-Q1.

Under special circumstances, a data frame can be shortened by the host. See the *Short SPI Frames* section for more information about artificially shortening communication frames.

8.5.1.8 SPI Communication Words

An SPI communication frame with the ADS131M06-Q1 is made of words. Words on DIN can contain commands, register settings during a register write, or a CRC of the input data. Words on DOUT can contain command responses, register settings during a register read, ADC conversion data, or CRC of the output data.

Words can be 16, 24, or 32 bits. The word size is configured by the WLENGTH[1:0] bits in the MODE register. The device defaults to a 24-bit word size. Commands, responses, CRC, and registers always contain 16 bits of actual data. These words are always most significant bit (MSB) aligned, and therefore the least significant bits (LSBs) are zero-padded to accommodate 24- or 32-bit word sizes. ADC conversion data are nominally 24 bits. The ADC truncates eight LSBs when the device is configured for 16-bit communication. There are two options for 32-bit communication available for ADC data that are configured by the WLENGTH[1:0] bits in the MODE register. Either the ADC data can be LSB padded with zeros or the data can be MSB sign extended.

8.5.1.9 ADC Conversion Data

The device provides conversion data for each channel at the data rate. The time when data are available relative to \overline{DRDY} asserting is determined by the channel phase calibration setting and the DRDY_SEL[1:0] bits in the MODE register when in continuous-conversion mode. All data are available immediately following \overline{DRDY} assertion in global-chop mode. The conversion status of all channels is available as the DRDY[5:0] bits in the STATUS register. The STATUS register content is automatically output as the response to the NULL command.



Conversion data are 24 bits. The data LSBs are truncated when the device operates with a 16-bit word size. The LSBs are zero padded or the MSBs sign extended when operating with a 32-bit word size depending on the setting of the WLENGTH[1:0] bits in the MODE register.

Data are given in binary two's complement format. Use 式 10 to calculate the size of one code (LSB).

1 LSB = (2.4 / Gain) / 2²⁴ = +FSR / 2²³

(10)

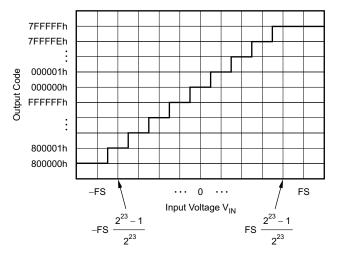
A positive full-scale input $V_{IN} \ge +FSR - 1 LSB = 1.2$ / Gain - 1 LSB produces an output code of 7FFFFFh and a negative full-scale input ($V_{IN} \le -FSR = -1.2$ / Gain) produces an output code of 800000h. The output clips at these codes for signals that exceed full-scale.

 \pm 8-10 summarizes the ideal output codes for different input signals.

| sac versus input orginal |
|--------------------------|
| IDEAL OUTPUT CODE |
| 7FFFFh |
| 000001h |
| 000000h |
| FFFFFh |
| 800000h |
| |

表 8-10. Ideal Output Code versus Input Signal

☑ 8-19 shows the mapping of the analog input signal to the output codes.



🛛 8-19. Code Transition Diagram

8.5.1.9.1 Collecting Data for the First Time or After a Pause in Data Collection

Take special precaution when collecting data for the first time or when beginning to collect data again after a pause. The internal mechanism that outputs data contains a first-in-first-out (FIFO) buffer that can store two samples of data per channel at a time. The DRDY flag for each channel in the STATUS register remains set until both samples for each channel are read from the device. This condition is not obvious under normal circumstances when the host is reading each consecutive sample from the device. In that case, the samples are cleared from the device each time new data are generated so the DRDY flag for each channel in the STATUS register remains set until negister is cleared with each read. However, both slots of the FIFO are full if a sample is missed or if data are not read for a period of time. Either strobe the SYNC/RESET pin to re-synchronize conversions and clear the FIFOs, or quickly read two data packets when data are read for the first time or after a gap in reading data. This process ensures predictable DRDY pin behavior. See the Synchronization section for information about the synchronization feature. These methods do not need to be employed if each channel data was read for each output data period from when the ADC was enabled.



⊠ 8-20 depicts an example of how to collect data after a period of the ADC running, but where no data are being retrieved. In this instance, the SYNC/RESET pin is used to clear the internal FIFOs and realign the ADS131M06-Q1 output data with the host.

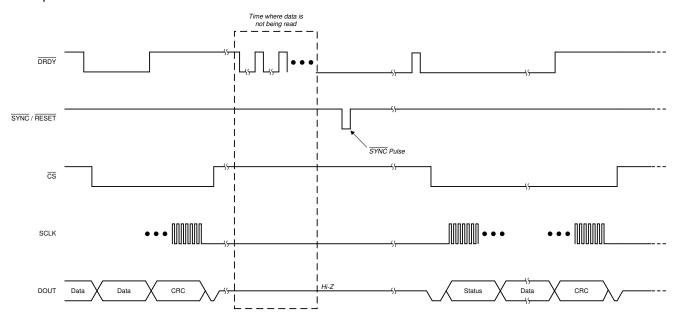
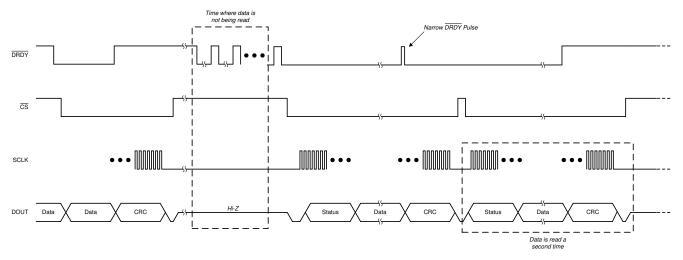


図 8-20. Collecting Data After a Pause in Data Collection Using the SYNC/RESET Pin

Another functionally equivalent method for clearing the FIFO after a pause in collecting data is to begin by reading two samples in quick succession. \boxtimes 8-21 depicts this method. This example shows when the DRDY_FMT bit in the MODE register is set to 0b indicating DRDY is a level output. There is a very narrow pulse on DRDY immediately after the first set of data are shifted out of the device. This pulse may be too narrow for some microcontrollers to detect. Therefore, do not rely upon this pulse but instead immediately read out the second data set after the first data set. The host operates synchronous to the device after the second word is read from the device.





8.5.1.10 Commands

表 8-11 contains a list of all valid commands, a short description of their functionality, their binary command word, and the expected response that appears in the following frame.



表 8-11. Command Definitions

| COMMAND | DESCRIPTION | COMMAND WORD | RESPONSE |
|---------|---|---------------------|--|
| NULL | No operation | 0000 0000 0000 0000 | STATUS register |
| RESET | Reset the device | 0000 0000 0001 0001 | 1111 1111 0010 0110 |
| STANDBY | Place the device into standby mode | 0000 0000 0010 0010 | 0000 0000 0010 0010 |
| WAKEUP | Wake the device from standby mode to conversion mode | 0000 0000 0011 0011 | 0000 0000 0011 0011 |
| LOCK | Lock the interface such that only the NULL, UNLOCK, and RREG commands are valid | 0000 0101 0101 0101 | 0000 0101 0101 0101 |
| UNLOCK | Unlock the interface after the interface is locked | 0000 0110 0101 0101 | 0000 0110 0101 0101 |
| RREG | Read <i>nnn nnnn</i> plus 1 registers beginning at address <i>a</i> aaaa a | 101a aaaa annn nnnn | dddd dddd dddd dddd or 111a aaa annn nnnn ⁽¹⁾ |
| WREG | Write <i>nnn nnnn</i> plus 1 registers beginning at address <i>a</i> aaaa a | 011a aaaa annn nnnn | 010a aaaa ammm mmmm (2) |

(1) When *nnn nnnn* is 0, the response is the requested register data *dddd dddd dddd dddd*. When *nnn nnnn* is greater than 0, the response begins with 111*a aaaa annn nnnn*, followed by the register data.

(2) In this case *mmm mmmm* represents the number of registers that are actually written minus one. This value may be less than *nnn nnnn* in some cases.

8.5.1.10.1 NULL (0000 0000 0000 0000)

The NULL command is the *no-operation* command that results in no registers read or written, and the state of the device remains unchanged. The intended use case for the NULL command is during ADC data capture. The command response for the NULL command is the contents of the STATUS register. Any invalid command also gives the NULL response.

8.5.1.10.2 RESET (0000 0000 0001 0001)

The RESET command resets the ADC to the register defaults. The command is latched by the device at the end of the frame. A reset occurs immediately after the command is latched. The host must wait for t_{REGACQ} after reset before communicating with the device to ensure the registers have assumed their default settings. The device sends an acknowledgment of FF26h when the ADC is properly RESET. The device responds with 0011h if the command word is sent but the frame is not completed and therefore the device is not reset. See the *RESET Command* section for more information regarding the operation of the reset command. 🛛 8-22 illustrates a properly sent RESET command frame.

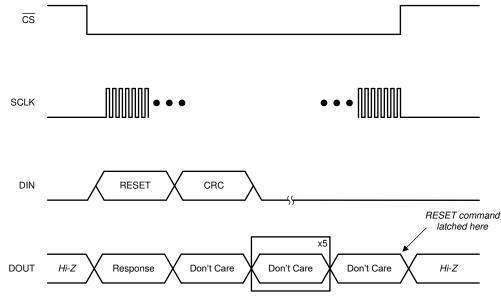


図 8-22. RESET Command Frame



8.5.1.10.3 STANDBY (0000 0000 0010 0010)

The STANDBY command places the device in a low-power standby mode. The command is latched by the device at the end of the frame. The device enters standby mode immediately after the command is latched. See the *Standby Mode* section for more information. This command has no effect if the device is already in standby mode.

8.5.1.10.4 WAKEUP (0000 0000 0011 0011)

The WAKEUP command returns the device to conversion mode from standby mode. This command has no effect if the device is already in conversion mode.

8.5.1.10.5 LOCK (0000 0101 0101 0101)

The LOCK command locks the interface, preventing the device from accidentally latching unwanted commands that can change the state of the device. When the interface is locked, the device only responds to the NULL, RREG, and UNLOCK commands. The device continues to output conversion data even when locked.

8.5.1.10.6 UNLOCK (0000 0110 0101 0101)

The UNLOCK command unlocks the interface if previously locked by the LOCK command.

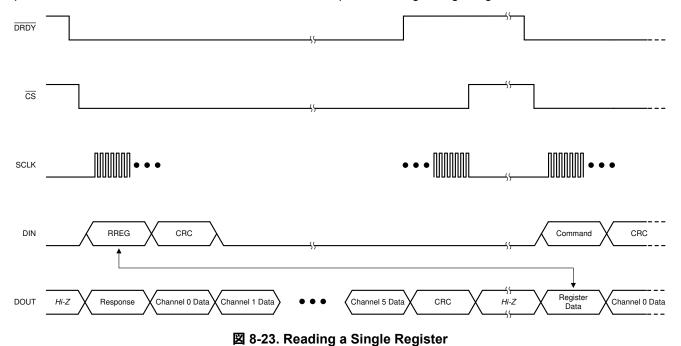
8.5.1.10.7 RREG (101a aaaa annn nnnn)

The RREG is used to read the device registers. The binary format of the command word is 101a aaaa annn nnnn, where a aaaa a is the binary address of the register to begin reading and nnn nnnn is the unsigned binary number of consecutive registers to read minus one. There are two cases for reading registers on the ADS131M06-Q1. When reading a single register (nnn nnnn = 000 0000b), the device outputs the register contents in the command response word of the following frame. If multiple registers are read using a single command (nnn nnnn > 000 0000b), the device outputs the requested register data sequentially in order of addresses.



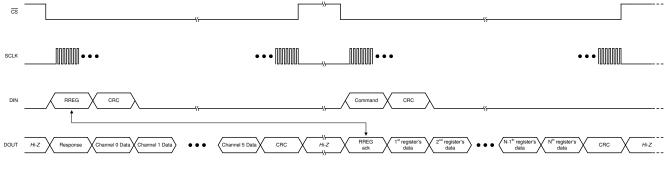
8.5.1.10.7.1 Reading a Single Register

Read a single register from the device by specifying *nnn nnnn* as zero in the RREG command word. As with all SPI commands on the ADS131M06-Q1, the response occurs on the output in the frame following the command. Instead of a unique acknowledgment word, the response word is the contents of the register whose address is specified in the command word. \boxtimes 8-23 shows an example of reading a single register.



8.5.1.10.7.2 Reading Multiple Registers

Multiple registers are read from the device when nnn nnnn is specified as a number greater than zero in the RREG command word. Like all SPI commands on the ADS131M06-Q1, the response occurs on the output in the frame following the command. Instead of a single acknowledgment word, the response spans multiple words in order to shift out all requested registers. Continue toggling SCLK to accommodate outputting the entire data stream. ADC conversion data are not output in the frame following an RREG command to read multiple registers. 🖾 8-24 shows an example of reading multiple registers.



2 8-24. Reading Multiple Registers



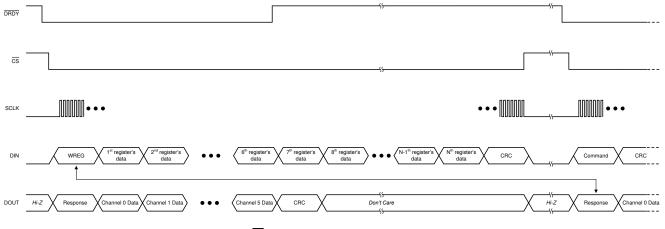
8.5.1.10.8 WREG (011a aaaa annn nnnn)

The WREG command allows writing an arbitrary number of contiguous device registers. The binary format of the command word is 011*a aaaa annn nnnn*, where *a aaaa a* is the binary address of the register to begin writing and *nnn nnnn* is the unsigned binary number of consecutive registers to write minus one. Send the data to be written immediately following the command word. Write the intended contents of each register into individual words, MSB aligned.

If the input CRC is enabled, write this CRC after the register data. The registers are written to the device as they are shifted into DIN. Therefore, a CRC error does not prevent an erroneous value from being written to a register. An input CRC error during a WREG command sets the CRC_ERR bit in the STATUS register.

The device ignores writes to read-only registers or to out-of-bounds addresses. Gaps in the register map address space are still included in the parameter *nnn nnnn*, but are not writeable so no change is made to them. The response to the WREG command that occurs in the following frame appears as 010*a aaaa ammm mmmm* where *mmm mmmm* is the number of registers actually written minus one. This number can be checked by the host against *nnn nnnn* to ensure the expected number of registers are written.

 \boxtimes 8-25 shows a typical WREG sequence. In this example, the number of registers to write is larger than the number of ADC channels and, therefore, the frame is extended beyond the ADC channels and output CRC word. Ensure all of the ADC data and output CRC are shifted out during each transaction where new data are available. Therefore, the frame must be extended beyond the number of words required to send the register data in some cases.



🛛 8-25. Writing Registers

8.5.1.11 Short SPI Frames

The SPI frame can be shortened to only send commands and receive responses if the ADCs are disabled and no ADC data are being output by the device. Read out all of the expected output data words from each sample period if the ADCs are enabled. Reading all of the data output with each frame ensures predictable DRDY pin behavior. If reading out all the data on each output data period is not feasible, see the *Collecting Data for the First Time or After a Pause in Data Collection* section on how to begin reading data again after a pause from when the ADCs were last enabled.

A short frame is not possible when using the RESET command. A full frame must be provided for a device reset to take place when providing the RESET command.



8.5.2 Synchronization

Synchronization can be performed by the host to ensure the ADC conversions are synchronized to an external event. For example, synchronization can realign the data capture to the expected timing of the host if a glitch on the clock causes the host and device to become out of synchronization.

Provide a negative pulse on the $\overline{SYNC/RESET}$ pin with a duration less than $t_{w(RSL)}$ but greater than a CLKIN period to trigger synchronization. The device internally compares the leading negative edge of the pulse to the internal clock that tracks the data rate. The internal data rate clock has timing equivalent to the \overline{DRDY} pin if configured to assert with a phase calibration setting of 0b. If the negative edge on $\overline{SYNC/RESET}$ aligns with the internal data rate clock, the device is determined to be synchronized and therefore no action is taken. If there is misalignment, the digital filters on the device are reset to be synchronized with the $\overline{SYNC/RESET}$ pulse. Conversions are immediately restarted when the $\overline{SYNC/RESET}$ pin is toggled in global-chop mode.

The phase calibration settings on all channels are retained during synchronization. Thus, channels with non-zero phase calibration settings generate conversion results less than a data rate period after the synchronization event occurs. However, the results can be corrupted and are not settled until the respective channels have at least three conversion cycles for the sinc³ filter to settle.



8.6 Registers

表 8-12 lists the ADS131M06-Q1 registers. All register offset addresses not listed in 表 8-12 should be considered as reserved locations and the register contents should not be modified.

| | | | | 表8 | 3-12. Regis | ter Map | | | | | | |
|------------|------------------|-----------|-------------------------|----------------------------------|---------------|-----------|-----------|--------------|---------------|----------|--|--|
| | | RESET | BIT 15 | BIT 14 | BIT 13 | BIT 12 | BIT 11 | BIT 10 | BIT 9 | BIT 8 | | |
| ADDRESS | REGISTER | VALUE | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 | | |
| DEVICE SET | TINGS AND INDICA | TORS (Rea | d-Only Registers | 5) | | | | | | | | |
| 00h | ID | 26xxh | RESERVED CHANCNT[3:0] | | | | | | | | | |
| 0011 | | 2000 | | | | RESE | RVED | | | | | |
| 01h | STATUS | 0500h | LOCK | F_RESYNC | REG_MAP | CRC_ERR | CRC_TYPE | RESET | WLENG | GTH[1:0] | | |
| 0111 | 01/100 | 000011 | RESERVED | RESERVED | DRDY5 | DRDY4 | DRDY3 | DRDY2 | DRDY1 | DRDY0 | | |
| GLOBAL SE | TTINGS ACROSS C | HANNELS | | | | | | | | | | |
| 02h | MODE | 0510h | RESE | RVED | REGCRC_EN | RX_CRC_EN | CRC_TYPE | RESET | WLENG | GTH[1:0] | | |
| 02.11 | | | | RESERVED | | TIMEOUT | DRDY_ | _SEL[1:0] | DRDY_HiZ | DRDY_FMT | | |
| 03h | CLOCK | 7F0Eh | RESE | RVED | CH5_EN | CH4_EN | CH3_EN | CH2_EN | CH1_EN | CH0_EN | | |
| 0011 | OLOOK | / UEI | | RESERVED | | | OSR[2:0] | | PW | R[1:0] | | |
| 04h | GAIN1 | 0000h | RESERVED | | PGAGAIN3[2:0] | | RESERVED | | PGAGAIN2[2:0] | | | |
| 0411 | GAINT | 000011 | RESERVED | | PGAGAIN1[2:0] | | RESERVED | | PGAGAIN0[2:0] | | | |
| 05h | CAIN2 | 00006 | | | | RESE | RVED | · | | | | |
| USH | GAIN2 | 0000h | RESERVED | | PGAGAIN5[2:0] | | RESERVED | | PGAGAIN4[2:0] | | | |
| 065 | CFG | 0600h | | RESERVED | | | GC_E | DLY[3:0] | | GC_EN | | |
| 06h | CFG | 0600h | CD_ALLCH | | CD_NUM[2:0] | | | CD_LEN[2:0] | | CD_EN | | |
| 071 | | | | | | CD_TH_I | MSB[15:8] | | | | | |
| 07h | THRSHLD_MSB | 0000h | | | | CD_TH_ | MSB[7:0] | | | | | |
| | | | | | | CD_TH_ | LSB[7:0] | | | | | |
| 08h | THRSHLD_LSB | 0000h | | RESI | ERVED | | | DCBLO | CK[3:0] | | | |
| CHANNEL-S | PECIFIC SETTINGS | 6 | | | | | | | | | | |
| | | | | | | PHAS | E0[9:2] | | | | | |
| 09h | CH0_CHG | 0000h | PHAS | PHASE0[1:0] RESERVED DCBLK0_DIS0 | | MUX | (0[1:0] | | | | | |
| | | | | | | OCAL0_I | MSB[15:8] | 11 | <u></u> | | | |
| 0Ah | CH0_OCAL_MSB | 0000h | | OCAL0_MSB[7:0] | | | | | | | | |
| | | | | | | OCAL0_ | LSB[7:0] | | | | | |
| 0Bh | CH0_OCAL_LSB | 0000h | | | | RESE | RVED | | | | | |
| | | | | | | GCAL0_I | MSB[15:8] | | | | | |
| 0Ch | CH0_GCAL_MSB | 8000h | | | | GCAL0 | MSB[7:0] | | | | | |
| | | | | | | | LSB[7:0] | | | | | |
| 0Dh | CH0_GCAL_LSB | 0000h | | | | | RVED | | | | | |
| | | | | | | | E1[9:2] | | | | | |
| 0Eh | CH1_CFG | 0000h | PHAS | E1[1:0] | | RESERVED | | DCBLK1 DIS0 | MUX | [1[1:0] | | |
| | | | | | | | MSB[15:8] | | | | | |
| 0Fh | CH1_OCAL_MSB | 0000h | | | | | MSB[7:0] | | | | | |
| | | | | | | | _LSB[7:0] | | | | | |
| 10h | CH1_OCAL_LSB | 0000h | | | | | RVED | | | | | |
| | | | | | | | MSB[15:8] | | | | | |
| 11h | CH1_GCAL_MSB | 8000h | | | | | MSB[7:0] | | | | | |
| | | | | | | | _LSB[7:0] | | | | | |
| 12h | CH1_GCAL_LSB | 0000h | | | | | | | | | | |
| | | | RESERVED PHASE2[9:2] | | | | | | | | | |
| 13h | CH2_CFG | 0000h | PHAS | E2[1:0] | | RESERVED | [0.2] | DCBLK2 DIS0 | MUX | [2[1:0] | | |
| | | | THAS | [] | | | MSB[15:8] | 5055112_0100 | WOX | | | |
| 14h | CH2_OCAL_MSB | 0000h | | | | | MSB[7:0] | | | | | |
| | | | | | | | LSB[7:0] | | | | | |
| 15h | CH2_OCAL_LSB | 0000h | | | | | | | | | | |
| | | | | RESERVED | | | | | | | | |
| | | | | SB 8000h GCAL2_MSB[15:8] | | | | | | | | |



| | | RESET | BIT 15 | BIT 14 | BIT 13 | BIT 12 | BIT 11 | BIT 10 | BIT 9 | BIT 8 |
|---------|--|---------|----------------|---------|--------|----------|-----------|-------------|-------|--------|
| ADDRESS | REGISTER | VALUE | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
| 476 | | 00001 | | | | GCAL2_ | LSB[7:0] | | | |
| 17h | CH2_GCAL_LSB | 0000h - | | | | RESE | RVED | | | |
| 4.01 | PHASE3[9:2] | | | | | | | | | |
| 18h | CH3_CFG | 0000h - | PHAS | E3[1:0] | | RESERVED | | DCBLK3_DIS0 | MUX | 3[1:0] |
| 19h | CH2_OCAL_MSB | 0000h | | | 4 | OCAL3_I | MSB[15:8] | | | |
| 1911 | CH2_OCAL_WISB | 000011 | | | | OCAL3_ | MSB[7:0] | | | |
| 1Ah | | 0000h | | | | OCAL3 | LSB[7:0] | | | |
| IAn | CH2_OCAL_LSB | 00000 | | | | RESE | RVED | | | |
| 105 | | 9000h | | | | GCAL3_ | MSB[15:8] | | | |
| 1Bh | CH2_GCAL_MSB | 8000h | | | | GCAL3_ | MSB[7:0] | | | |
| 105 | | 00005 | | | | GCAL3 | LSB[7:0] | | | |
| 1Ch | CH2_GCAL_LSB | 0000h | | | | RESE | RVED | | | |
| 105 | 0114,050 | 00001- | | | | PHAS | E4[9:2] | | | |
| 1Dh | CH4_CFG | 0000h - | PHAS | E4[1:0] | | RESERVED | | DCBLK4_DIS0 | MUX | 4[1:0] |
| 1Eh | | 0000h | | | 4 | OCAL4_I | MSB[15:8] | | | |
| IEN | CH4_OCAL_MSB | 00000 | OCAL4_MSB[7:0] | | | | | | | |
| 1Fh | CH4_OCAL_LSB | 0000h | | | | OCAL4 | LSB[7:0] | | | |
| IFN | CH4_OCAL_LSB | 00000 | RESERVED | | | | | | | |
| 20h | CH4 GCAL MSB | 8000h | | | | GCAL4_I | MSB[15:8] | | | |
| 2011 | CH4_GCAL_WISB | 800011 | | | | GCAL4_ | MSB[7:0] | | | |
| 21h | CH4_GCAL_LSB | 0000h | | | | GCAL4_ | LSB[7:0] | | | |
| 2111 | CH4_GOAL_LOD | | | | | RESE | RVED | | | |
| 22h | CH5 CFG | 0000h | | | | PHAS | E5[9:2] | | | |
| 2211 | CH5_CFG | 000011 | PHAS | E5[1:0] | | RESERVED | | DCBLK5_DIS0 | MUX | 5[1:0] |
| 23h | CH5_OCAL_MSB | 0000h | | | | OCAL5_ | MSB[15:8] | | | |
| 2011 | | | | | | OCAL5_ | MSB[7:0] | | | |
| 24h | CH5_OCAL_LSB | 0000h | | | | OCAL5 | LSB[7:0] | | | |
| 240 | UND_UUAL_LOB | 000011 | | | | RESE | RVED | | | |
| 25h | CH5 GCAL MSB | 8000h | | | | GCAL5_ | MSB[15:8] | | | |
| 2011 | UNU_UUUUUUUUUUUUUUUUUUUUUUUUUUUUUUUUUU | 000011 | | | | GCAL5_ | MSB[7:0] | | | |
| 26h | CH5_GCAL_LSB | 0000h | | | | GCAL5_ | LSB[7:0] | | | |
| 2011 | CHO_COAL_LOD | 300011 | | | | RESE | RVED | | | |
| 3Eh | REGMAP_CRC | 0000h | | | | REG_C | RC[15:8] | | | |
| JLII | REGIMAR_ORC | 000011 | | | | REG_C | CRC[7:0] | | | |
| 3Fh | RESERVED | 0000h | | | | RESE | RVED | | | |
| 0111 | 3FN RESERVED | 000001 | | | | RESE | RVED | | | |

Complex bit access types are encoded to fit into small table cells. \pm 8-13 shows the codes that are used for access types in this section.

| | A o-15. Access Type Codes | | | | | | | |
|------------------|---------------------------|--|--|--|--|--|--|--|
| Access Type | Code | Description | | | | | | |
| Read Type | Read Type | | | | | | | |
| R R Read | | | | | | | | |
| Write Type | | | | | | | | |
| W | W | Write | | | | | | |
| Reset or Default | Value | | | | | | | |
| -n | | Value after reset or the default value | | | | | | |

表 8-13. Access Type Codes



8.6.1 ID Register (Address = 00h) [reset = 26xxh]

The ID register is shown in \boxtimes 8-26 and described in $\textcircled{}{$ 8-14.

Return to the Summary Table.

| | 図 8-26. ID Register | | | | | | | | | | |
|----|-----------------------|------|-------|------|------|-----|---|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | RESERVED CHANCNT[3:0] | | | | | | | | | | |
| | R-00 | 010b | | | R-01 | 10b | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | | | RESEF | RVED | | | | | | | |
| | R-xxxxxxb | | | | | | | | | | |
| | | | | | | | | | | | |

表 8-14. ID Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------|------|----------|---|
| 15:12 | RESERVED | R | 0010b | Reserved |
| | | | | always reads 0010b. |
| 11:8 | CHANCNT[3:0] | R | 0110b | Channel count |
| | | | | always reads 0110b. |
| 7:0 | RESERVED | R | xxxxxxxb | Reserved |
| | | | | Values are subject to change without notice |



8.6.2 STATUS Register (Address = 01h) [reset = 0500h]

The STATUS register is shown in \boxtimes 8-27 and described in $\cancel{5}$ 8-15.

Return to the Summary Table.

| | 図 8-27. STATUS Register | | | | | | | | | |
|------|-------------------------|---------|---------|----------|-------|-------|----------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| LOCK | F_RESYNC | REG_MAP | CRC_ERR | CRC_TYPE | RESET | WLENG | GTH[1:0] | | | |
| R-0b | R-0b | R-0b | R-0b | R-0b | R-1b | R-(|)1b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| RESE | RESERVED | | DRDY4 | DRDY3 | DRDY2 | DRDY1 | DRDY0 | | | |
| R-0b | R-0b | R-0b | R-0b | R-0b | R-0b | R-0b | R-0b | | | |

表 8-15. STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|--------------|------|-------|--|
| 15 | LOCK | R | 0b | SPI interface lock indicator |
| | | | | 0b = Unlocked (default) |
| | | | | 1b = Locked |
| 14 | F_RESYNC | R | 0b | ADC resynchronization indicator. |
| | | | | Bit is set each time the ADC resynchronizes. |
| | | | | 0b = No resynchronization (default) |
| | | | | 1b = Resynchronization occurred |
| 13 | REG_MAP | R | 0b | Register map CRC fault indicator |
| | | | | 0b = No change in the register map CRC (default) |
| | | | | 1b = Register map CRC changed |
| 12 | CRC_ERR | R | 0b | SPI input CRC error indicator |
| | | | | 0b = No CRC error (default) |
| | | | | 1b = Input CRC error occured |
| 11 | CRC_TYPE | R | 0b | CRC type |
| | | | | 0b = 16 bit CCITT (default) |
| | | | | 1b = 16 bit ANSI |
| 10 | RESET | R | 1b | Reset status |
| | | | | 0b = Not reset |
| | | | | 1b = Reset occured (default) |
| 9:8 | WLENGTH[1:0] | R | 01b | Data word length |
| | | | | 00b = 16 bit |
| | | | | 01b = 24 bits (default) |
| | | | | 10b = 32 bits - zero padding |
| | | | | 11b = 32 bits - sign extension for 24 bit ADC data |
| 7:6 | RESERVED | R | 00b | Reserved |
| | | | | always reads 00b |



| | a o-15. STATUS Register Field Descriptions (continued) | | | | | | | |
|-----|--|------|-------|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | |
| 5 | DRDY5 | R | 0b | Channel 5 ADC data available indicator | | | | |
| | | | | 0b = No new data available | | | | |
| | | | | 1b = New data are available | | | | |
| 4 | DRDY4 | R | 0b | Channel 4 ADC data available indicator | | | | |
| | | | | 0b = No new data available | | | | |
| | | | | 1b = New data are available | | | | |
| 3 | DRDY3 | R | 0b | Channel 3 ADC data available indicator | | | | |
| | | | | 0b = No new data available | | | | |
| | | | | 1b = New data are available | | | | |
| 2 | DRDY2 | R | 0b | Channel 2 ADC data available indicator | | | | |
| | | | | 0b = No new data available | | | | |
| | | | | 1b = New data are available | | | | |
| 1 | DRDY1 | R | 0b | Channel 1 ADC data available indicator | | | | |
| | | | | 0b = No new data available | | | | |
| | | | | 1b = New data are available | | | | |
| 0 | DRDY0 | R | 0b | Channel 0 ADC data available indicator | | | | |
| | | | | 0b = No new data available | | | | |
| | | | | 1b = New data are available | | | | |
| | | | | I | | | | |

表 8-15. STATUS Register Field Descriptions (continued)



8.6.3 MODE Register (Address = 02h) [reset = 0510h]

The MODE register is shown in \boxtimes 8-28 and described in $\cancel{5}$ 8-16.

Return to the Summary Table.

| | 図 8-28. MODE Register | | | | | | | | |
|-------|-----------------------|----|--------|----------|----------|----------|----------|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| RESER | RESERVED REG_CRC_EN | | | CRC_TYPE | RESET | WLENG | GTH[1:0] | | |
| R/W-0 | R/W-00b | | R/W-0b | R/W-0b | R/W-1b | R/W | -01b | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESERVED | | | DRDY_S | SEL[1:0] | DRDY_HiZ | DRDY_FMT | | |
| | R/W-000b | | R/W-1b | R/W | -00b | R/W-0b | R/W-0b | | |

表 8-16. MODE Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------|------|-------|---|
| 15:14 | RESERVED | R/W | 00b | Reserved |
| | | | | always reads 00b |
| 13 | REG_CRC_EN | R/W | 0b | Register Map CRC enable |
| | | | | 0b = Disabled (default) |
| | | | | 1b = Enabled |
| 12 | RX_CRC_EN | R/W | 0b | SPI input CRC enable |
| | | | | 0b = Disabled (default) |
| | | | | 1b = Enabled |
| 11 | CRC_TYPE | R/W | 0b | SPI and register map CRC type |
| | | | | 0b = 16-bit CCITT (default) |
| | | | | 1b = 16-bit ANSI |
| 10 | RESET | R/W | 1b | Reset |
| | | | | write 0b to clear this bit in the STATUS register |
| | | | | 0b = No reset |
| | | | | 1b = Reset happened (default by definition) |
| 9:8 | WLENGTH[1:0] | R/W | 01b | Data word length selection |
| | | | | 00b = 16 bits |
| | | | | 01b = 24 bits (default) |
| | | | | 10b = 32 bits: LSB zero padding |
| | | | | 11b = 32 bits: MSB sign extension |
| 7:5 | RESERVED | R/W | 000b | Reserved |
| | | | | always write 000b |
| 4 | TIMEOUT | R/W | 1b | SPI Timeout enable |
| | | | | 0b = Disabled |
| | | | | 1b = Enabled (default) |



表 8-16. MODE Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|---------------|------|-------|--|
| 3:2 | DRDY_SEL[1:0] | R/W | 00b | DRDY pin signal source selection |
| | | | | 00b = Most lagging enabled channel (default) |
| | | | | 01b = Logic OR of all the enabled channels |
| | | | | 10b = Most leading enabled channel |
| | | | | 11b = Most leading enabled channel |
| 1 | DRDY_HiZ | R/W | 0b | DRDY pin state when conversion data is not available |
| | | | | 0b = Logic high (default) |
| | | | | 1b = High impedance |
| 0 | DRDY_FMT | R/W | 0b | DRDY signal format when conversion data is available |
| | | | | 0b = Logic low (default) |
| | | | | 1b = Low pulse with a fixed duration |



8.6.4 CLOCK Register (Address = 03h) [reset = 7F0Eh]

The CLOCK register is shown in \boxtimes 8-29 and described in $\cancel{5}$ 8-17.

Return to the Summary Table.

| | 図 8-29. CLOCK Register | | | | | | | |
|----------|------------------------|----------|--------|----------|--------|--------|--------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| RESE | ERVED | CH5_EN | CH4_EN | CH3_EN | CH2_EN | CH1_EN | CH0_EN | |
| R/W-0b | R/W-0b | R/W-1b | R/W-1b | R/W-1b | R/W-1b | R/W-1b | R/W-1b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| XTAL_DIS | EXTREF_EN | RESERVED | | OSR[2:0] | | PV | VR | |
| R/W-0b | R/W-0b | R/W-0b | | R/W-011b | | R/W | -10b | |

表 8-17. CLOCK Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-----------|------|-------|------------------------------|
| 15:14 | RESERVED | R | 00b | Reserved always reads 00b |
| 13 | CH5_EN | R/W | 1b | Channel 5 ADC enable |
| | | | | 0b = Disabled |
| | | | | 1b = Enabled (default) |
| 12 | CH4_EN | R/W | 1b | Channel 4 ADC enable |
| | | | | 0b = Disabled |
| | | | | 1b = Enabled (default) |
| 11 | CH3_EN | R/W | 1b | Channel 3 ADC enable |
| | | | | 0b = Disabled |
| | | | | 1b = Enabled (default) |
| 10 | CH2_EN | R/W | 1b | Channel 2 ADC enable |
| | | | | 0b = Disabled |
| | | | | 1b = Enabled (default) |
| 9 | CH1_EN | R/W | 1b | Channel 1 ADC enable |
| | | | | 0b = Disabled |
| | | | | 1b = Enabled (default) |
| 8 | CH0_EN | R/W | 1b | Channel 0 ADC enable |
| | | | | 0b = Disabled |
| | | | | 1b = Enabled (default) |
| 7 | XTAL_DIS | R/W | 0b | Crystal oscillator disable |
| | | | | 0b = Enabled (default) |
| | | | | 1b = Disabled |
| 6 | EXTREF_EN | R/W | 0b | External reference enable |
| | | | | 0b = Disabled (default) |
| | | | | 1b = Enabled |



| | | | | Field Descriptions (continued) |
|-----|----------|------|-------|--|
| Bit | Field | Туре | Reset | Description |
| 5 | RESERVED | R/W | 0b | Reserved |
| | | | | always write 0b |
| 4:2 | OSR[2:0] | R/W | 011b | Modulator oversampling ratio selection |
| | | | | 000b = 128 |
| | | | | 001b = 256 |
| | | | | 010b = 512 |
| | | | | 011b = 1024 (default) |
| | | | | 100b = 2048 |
| | | | | 101b = 4096 |
| | | | | 110b = 8192 |
| | | | | 111b = 16384 |
| 1:0 | PWR | R/W | 10b | Power mode selection |
| | | | | 00b = Very-low-power |
| | | | | 01b = Low-power |
| | | | | 10b = High-resolution (default) |
| | | | | 11b = High-resolution |
| | | | | |

表 8-17. CLOCK Register Field Descriptions (continued)

8.6.5 GAIN1 Register (Address = 4h) [reset = 0000h]

The GAIN1 register is shown in \boxtimes 8-30 and described in $\cancel{5}$ 8-18.

Return to the Summary Table.

| 図 8-30. GAIN1 Register | | | | | | | | |
|------------------------|---------------|---------------|----------|----------|---------------|---------------|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| RESERVED | | PGAGAIN3[2:0] | | RESERVED | | PGAGAIN2[2:0] | | |
| R/W-0b | | R/W-000b | | R/W-0b | | R/W-000b | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| RESERVED | PGAGAIN1[2:0] | | RESERVED | | PGAGAIN0[2:0] | | | |
| R/W-0b | R/W-000b | | | R/W-0b | | R/W-000b | | |

表 8-18. GAIN1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------|------|-------|----------------------------------|
| 15 | RESERVED | R/W | 0b | Reserved |
| | | | | always write 0b |
| 14:12 | PGAGAIN3[2:0] | R/W | 000b | PGA gain selection for channel 3 |
| | | | | 000b = 1 (default) |
| | | | | 001b = 2 |
| | | | | 010b = 4 |
| | | | | 011b = 8 |
| | | | | 100b = 16 |
| | | | | 101b = 32 |
| | | | | 110b = 64 |
| | | | | 111b = 128 |
| 11 | RESERVED | R/W | 0b | Reserved |
| | | | | always write 0b |
| 10:8 | PGAGAIN2[2:0] | R/W | 000b | PGA gain selection for channel 2 |
| | | | | 000b = 1 (default) |
| | | | | 001b = 2 |
| | | | | 010b = 4 |
| | | | | 011b = 8 |
| | | | | 100b = 16 |
| | | | | 101b = 32 |
| | | | | 110b = 64 |
| | | | | 111b = 128 |
| 7 | RESERVED | R/W | Ob | Reserved |
| | | | | always write 0b |



表 8-18. GAIN1 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|---------------|------|-------|----------------------------------|
| 6:4 | PGAGAIN1[2:0] | R/W | 000b | PGA gain selection for channel 1 |
| | | | | 000b = 1 (default) |
| | | | | 001b = 2 |
| | | | | 010b = 4 |
| | | | | 011b = 8 |
| | | | | 100b = 16 |
| | | | | 101b = 32 |
| | | | | 110b = 64 |
| | | | | 111b = 128 |
| 3 | RESERVED | R/W | 0b | Reserved |
| | | | | always write 0b |
| 2:0 | PGAGAIN0[2:0] | R/W | 000b | PGA gain selection for channel 0 |
| | | | | 000b = 1 (default) |
| | | | | 001b = 2 |
| | | | | 010b = 4 |
| | | | | 011b = 8 |
| | | | | 100b = 16 |
| | | | | 101b = 32 |
| | | | | 110b = 64 |
| | | | | 111b = 128 |

8.6.6 GAIN2 Register (Address = 5h) [reset = 0000h]

The GAIN2 register is shown in \boxtimes 8-31 and described in $\cancel{5}$ 8-19.

Return to the Summary Table.

| | | | 🖾 8-31. GA | IN2 Register | | | |
|----------|---------------|----|------------|--------------|----|---------------|---|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | | | RESE | RVED | | | |
| | | | R/W-000000 | 000000000b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | PGAGAIN5[2:0] | | | RESERVED | | PGAGAIN4[2:0] | |
| R/W-0b | R/W-000b | | | R/W-0b | | R/W-000b | |
| | | | | | | | |

表 8-19. GAIN2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-----------|----------------------------------|
| 15:7 | RESERVED | R/W | 00000000b | Reserved |
| | | | | always write 00000000b |
| 6:4 | PGAGAIN5[2:0] | R/W | 000b | PGA gain selection for channel 5 |
| | | | | 000b = 1 |
| | | | | 001b = 2 |
| | | | | 010b = 4 |
| | | | | 011b = 8 |
| | | | | 100b = 16 |
| | | | | 101b = 32 |
| | | | | 110b = 64 |
| | | | | 111b =128 |
| 3 | RESERVED | R/W | 0b | Reserved |
| | | | | always write 0b |
| 2:0 | PGAGAIN4[2:0] | R/W | 000b | PGA gain selection for channel 4 |
| | | | | 000b = 1 |
| | | | | 001b = 2 |
| | | | | 010b = 4 |
| | | | | 011b = 8 |
| | | | | 100b = 16 |
| | | | | 101b = 32 |
| | | | | 110b = 64 |
| | | | | 111b = 128 |
| | | | | |



8.6.7 CFG Register (Address = 06h) [reset = 0600h]

The CFG register is shown in \boxtimes 8-32 and described in \cancel{R} 8-20.

Return to the Summary Table.

| 図 8-32. CFG Register | | | | | | | |
|----------------------|----------|-------------|----|--------|-------------|---|-------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | RESERVED | | | GC_D | LY[3:0] | | GC_EN |
| R/W-000b | | | | R/W-0b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| CD_ALLCH | | CD_NUM[2:0] | | | CD_LEN[2:0] | | CD_EN |
| R/W-0b | R/W-000b | | | | R/W-0b | | |

| Bit | Field | Туре | Reset | Description |
|-------|-------------|------|-------|---|
| 15:13 | RESERVED | R/W | 000b | Reserved always write 000b |
| 12:9 | GC_DLY[3:0] | R/W | 0011b | Global-chop delay selection Delay in modulator clock periods before measurement begins |
| | | | | 0000b = 2 |
| | | | | 0000b = 2 0001b = 4 |
| | | | | |
| | | | | 0010b = 8 |
| | | | | 0011b = 16 (default) |
| | | | | 0100b = 32 |
| | | | | 0101b = 64 |
| | | | | 0110b = 128 |
| | | | | 0111b = 256 |
| | | | | 1000b = 512 |
| | | | | 1001b = 1024 |
| | | | | 1010b = 2048 |
| | | | | 1011b = 4096 |
| | | | | 1100b = 8192 |
| | | | | 1101b = 16384 |
| | | | | 1110b = 32768 |
| | | | | 1111b = 65536 |
| 8 | GC_EN | R/W | 0b | Global-chop enable |
| | | | | 0b = Disabled (default) |
| | | | | 1b = Enabled |
| 7 | CD_ALLCH | R/W | 0b | Current-detect channels selection |
| | | | | Channels required to trigger current-detect |
| | | | | 0b = Any channel (default) |
| | | | | 1b = All channels |

表 8-20. CFG Register Field Descriptions

| Ų | Texas Instruments |
|---|----------------------|
| | www.tij.co.jp |

| Bit | Field | Туре | Reset | Descriptions (continued) |
|-----|-------------|------|-------|---|
| 6:4 | CD_NUM[2:0] | R/W | 000b | Number of current-detect exceeded thresholds selection |
| | | | | Number of current-detect exceeded thresholds to trigger a detection |
| | | | | 000b = 1 (default) |
| | | | | 001b = 2 |
| | | | | 010b = 4 |
| | | | | 011b = 8 |
| | | | | 100b = 16 |
| | | | | 101b = 32 |
| | | | | 110b = 64 |
| | | | | 111b = 128 |
| 3:1 | CD_LEN[2:0] | R/W | 000b | Current-detect measurement length selection |
| | | | | Current-detect measurement length in conversion periods |
| | | | | 000b = 128 (default) |
| | | | | 001b = 256 |
| | | | | 010b = 512 |
| | | | | 011b = 768 |
| | | | | 100b = 1280 |
| | | | | 101b = 1792 |
| | | | | 110b = 2560 |
| | | | | 111b = 3584 |
| 0 | CD_EN | R/W | 0b | Current-detect mode enable |
| | | | | 0b = Disabled (default) |
| | | | | 1b = Enabled |
| | | 1 | I | 1 |

表 8-20. CFG Register Field Descriptions (continued)



8.6.8 THRSHLD_MSB Register (Address = 07h) [reset = 0000h]

The THRSHLD_MSB register is shown in 図 8-33 and described in 表 8-21.

Return to the Summary Table.

図 8-33. THRSHLD_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
|------------------|-------------------|----|------------|------------|----|---|---|--|--|--|
| CD_TH_MSB[23:16] | | | | | | | | | | |
| | R/W-000000000000b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | CD_TH_MSB[15:8] | | | | | | | | | |
| | | | R/W-000000 | 000000000b | | | | | | |
| | | | | | | | | | | |

表 8-21. THRSHLD_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|----------|---|
| 15:0 | CD_TH_MSB[23:8] | R/W | 00000000 | Current-detect mode threshold register bits [23:8]. Value provided in two's complement format. |

8.6.9 THRSHLD_LSB Register (Address = 08h) [reset = 0000h]

The THRSHLD_LSB register is shown in \boxtimes 8-34 and described in \cancel{R} 8-22.

Return to the Summary Table.

図 8-34. THRSHLD_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|----------------|--------------|------|----|--------------|-------|------|---|--|--|
| CD_TH_LSB[7:0] | | | | | | | | | |
| | R/W-0000000b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESE | RVED | | DCBLOCK[3:0] | | | | | |
| | R-00 | 000b | | | R/W-0 | 000b | | | |
| | | | | | | | | | |

表 8-22. THRSHLD_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|----------|--|
| 15:8 | CD_TH_LSB[7:0] | R/W | 0000000b | Current-detect mode threshold register bits [7:0] Value provided in two's complement format |
| 7:4 | RESERVED | R | 0000b | Reserved |
| 7.4 | | | 00000 | always reads 0000b |
| 3:0 | DCBLOCK[3:0] | R/W | 0000b | DC Block filter setting |
| | | | | See 表 8-4 for details |

8.6.10 CH0_CFG Register (Address = 09h) [reset = 0000h]

The CH0_CFG register is shown in \boxtimes 8-35 and described in $\cancel{5}$ 8-23.

Return to the Summary Table.

| 図 8-35. CH0_CFG Register | | | | | | | | | | |
|--------------------------|---|----|--------|----|--------|-----|-------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | PHASE0[9:2] | | | | | | | | | |
| | R/W-00000000b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| PHASE | PHASE0[1:0] RESERVED DCBLK0_DIS MUX0[1:0] | | | | | | | | | |
| R/W-0000 | 000000b | | R-000b | | R/W-0b | R/W | /-00b | | | |

| | 表 8-23. CH0_CFG Register Field Descriptions | | | | | | | | |
|------|---|------|----------------|--|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | | |
| 15:6 | PHASE0[9:0] | R/W | 000000000 b | Channel 0 phase delay Phase delay in modulator clock cycles provided in two's complement format. See \gtrsim 8-5 for details. | | | | | |
| 5:3 | RESERVED | R | 000b | Reserved always reads 000b | | | | | |
| 2 | DCBLK0_DIS | R/W | Ob | Channel 0 DC Block filter disable 0b = Controlled by DCBLOCK[3:0] (default) 1b = Disabled for this channel | | | | | |
| 1:0 | MUX0[1:0] | R/W | 00Ь | Channel 0 input selection 00b = AIN0P and AIN0N (default) 01b = ADC inputs shorted 10b = Positive DC test signal 11b = Negative DC test signal | | | | | |



8.6.11 CH0_OCAL_MSB Register (Address = 0Ah) [reset = 0000h]

The CH0_OCAL_MSB register is shown in \boxtimes 8-36 and described in \cancel{B} 8-24.

Return to the Summary Table.

図 8-36. CH0_OCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|-----------------|-------------------|----|------------|------------|----|---|---|--|--|
| OCAL0_MSB[15:8] | | | | | | | | | |
| | R/W-000000000000b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | OCAL0_MSB[7:0] | | | | | | | | |
| | | | R/W-000000 | 000000000b | | | | | |

表 8-24. CH0_OCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|----------|--|
| 15:0 | OCAL0_MSB[15:0] | R/W | 00000000 | Channel 0 offset calibration register bits [23:8]. Value provided in two's complement format. |

8.6.12 CH0_OCAL_LSB Register (Address = 0Bh) [reset = 0000h]

The CH0_OCAL_LSB register is shown in \boxtimes 8-37 and described in \cancel{k} 8-25.

Return to the Summary Table.

図 8-37. CH0_OCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|----------------|--------------|----|--------|-------|----|---|---|--|--|
| OCAL0_LSB[7:0] | | | | | | | | | |
| | R/W-0000000b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESERVED | | | | | | | | |
| | | | R-0000 | 0000b | | | | | |
| | | | | | | | | | |

表 8-25. CH0_OCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|----------|---|
| 15:8 | OCAL0_LSB[7:0] | R/W | 0000000b | Channel 0 offset calibration register bits [7:0]. |
| | | | | Value provided in two's complement format. |
| 7:0 | RESERVED | R | 0000000b | Reserved |
| | | | | always reads 00000000b |

8.6.13 CH0_GCAL_MSB Register (Address = 0Ch) [reset = 8000h]

The CH0_GCAL_MSB register is shown in \boxtimes 8-38 and described in \cancel{a} 8-26.

Return to the Summary Table.

図 8-38. CH0_GCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
|-----------------|-------------------|----|----|----|----|---|---|--|--|--|
| GCAL0_MSB[15:8] | | | | | | | | | | |
| | R/W-100000000000b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | GCAL0_MSB[7:0] | | | | | | | | | |
| | R/W-10000000000b | | | | | | | | | |
| 1 | | | | | | | | | | |

表 8-26. CH0_GCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------|------|--------|--|
| 15:0 | GCAL0_MSB | R/W | 000000 | Channel 0 gain calibration register bits [23:8] Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |

8.6.14 CH0_GCAL_LSB Register (Address = 0Dh) [reset = 0000h]

The CH0_GCAL_LSB register is shown in \boxtimes 8-39 and described in \cancel{k} 8-27.

Return to the Summary Table.

図 8-39. CH0_GCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
|--------------|------------|----|------|------|----|---|---|--|--|--|--|
| | GCAL0_LSB | | | | | | | | | | |
| R/W-0000000b | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | | | RESE | RVED | | | | | | | |
| | R-0000000b | | | | | | | | | | |
| 1 | | | | | | | | | | | |

表 8-27. CH0_GCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description | |
|------|----------------|------|----------|--|--|
| 15:8 | GCAL0_LSB[7:0] | R/W | 0000000b | Channel 0 gain calibration register bits [7:0] | |
| | | | | Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ | |
| 7:0 | RESERVED | R | 0000000b | Reserved | |
| | | | | always reads 00000000b | |



8.6.15 CH1_CFG Register (Address = 0Eh) [reset = 0000h]

The CH1_CFG register is shown in \boxtimes 8-40 and described in $\cancel{5}$ 8-28.

Return to the Summary Table.

| 図 8-40. CH1_CFG Register | | | | | | | | | | |
|--------------------------|------------------------------------|----|----------|----|----|------|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | PHASE1[9:2] | | | | | | | | | |
| | R/W-00000000b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| PHASE | PHASE1[1:0] | | RESERVED | | | MUX1 | | | | |
| R/W-0000 | R/W-00000000b R-000b R/W-0b R/W-0b | | | | | | | | | |
| | | | | | | | | | | |

| | 表 8-28. CH1_CFG Register Field Descriptions | | | | | | | | | | |
|------|---|------|-----------------|--|--|--|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | | | | |
| 15:6 | PHASE1[9:0] | R/W | 0000000000 b | Channel 1 phase delay Phase delay in modulator clock cycles provided in two's complement format. See $\frac{1}{8}$ 8-5 for details. | | | | | | | |
| 5:3 | RESERVED | R | 000b | Reserved always reads 000b | | | | | | | |
| 2 | DCBLK1_DIS | R/W | Ob | Channel 1 DC Block filter disable 0b = Controlled by DCBLOCK[3:0] (default) 1b = Disabled for this channel | | | | | | | |
| 1:0 | MUX1 | R/W | 00b | Channel 1 input selection 00b = AIN1P and AIN1N (default) 01b = ADC inputs shorted 10b = Positive DC test signal 11b = Negative DC test signal | | | | | | | |

8.6.16 CH1_OCAL_MSB Register (Address = 0Fh) [reset = 0000h]

The CH1_OCAL_MSB register is shown in \boxtimes 8-41 and described in \cancel{B} 8-29.

Return to the Summary Table.

図 8-41. CH1_OCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
|--------------------|-------------------|----|--------|----------|----|---|---|--|--|--|--|
| | OCAL1_MSB[15:8] | | | | | | | | | | |
| R/W-0000000000000b | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | | | OCAL1_ | MSB[7:0] | | | | | | | |
| | R/W-000000000000b | | | | | | | | | | |

表 8-29. CH1_OCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|-----------------------|--|
| 15:0 | OCAL1_MSB[15:0] | R/W | 00000000 00000000b | Channel 1 offset calibration register bits [23:8] Value provided in two's complement format |

8.6.17 CH1_OCAL_LSB Register (Address = 10h) [reset = 0000h]

The CH1_OCAL_LSB register is shown in \boxtimes 8-42 and described in \cancel{k} 8-30.

Return to the Summary Table.

図 8-42. CH1_OCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
|----|----------------|----|----|----|----|---|---|--|--|--|--|
| | OCAL1_LSB[7:0] | | | | | | | | | | |
| | R/W-0000000b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | RESERVED | | | | | | | | | | |
| | R-0000000b | | | | | | | | | | |

表 8-30. CH1_OCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|----------|--|
| 15:8 | OCAL1_LSB[7:0] | R/W | 0000000b | Channel 1 offset calibration register bits [7:0] |
| | | | | Value provided in two's complement format |
| 7:0 | RESERVED | R | 0000000b | Reserved |
| | | | | always reads 00000000b |



8.6.18 CH1_GCAL_MSB Register (Address = 11h) [reset = 8000h]

The CH1_GCAL_MSB register is shown in \boxtimes 8-43 and described in \cancel{a} 8-31.

Return to the Summary Table.

図 8-43. CH1_GCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | | |
|--------------------|-------------------|----|----|----|----|---|---|--|--|--|--|--|
| | GCAL1_MSB[15:8] | | | | | | | | | | | |
| R/W-1000000000000b | | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | | |
| | GCAL1_MSB[7:0] | | | | | | | | | | | |
| | R/W-100000000000b | | | | | | | | | | | |

表 8-31. CH1_GCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|--------|---|
| 15:0 | GCAL1_MSB[15:0] | R/W | 000000 | Channel 1 gain calibration register bits [23:8] Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1)/2^{24}$ |

8.6.19 CH1_GCAL_LSB Register (Address = 12h) [reset = 0000h]

The CH1_GCAL_LSB register is shown in \boxtimes 8-44 and described in \cancel{k} 8-32.

Return to the Summary Table.

図 8-44. CH1_GCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
|----|-----------------|----|----|----|----|---|---|--|--|--|--|
| | GCAL1_LSB[7:0] | | | | | | | | | | |
| | R/W-0000000b | | | | | | | | | | |
| 7 | 7 6 5 4 3 2 1 0 | | | | | | | | | | |
| | RESERVED | | | | | | | | | | |
| | R-0000000b | | | | | | | | | | |

表 8-32. CH1_GCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|----------|--|
| 15:8 | GCAL1_LSB[7:0] | R/W | 0000000b | Channel 1 gain calibration register bits [7:0] |
| | | | | Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |
| 7:0 | RESERVED | R | 0000000b | Reserved |
| | | | | always reads 00000000b |

8.6.20 CH2_CFG Register (Address = 13h) [reset = 0000h]

The CH2_CFG register is shown in \boxtimes 8-45 and described in $\cancel{5}$ 8-33.

Return to the Summary Table.

| | | | 🖾 8-45. CH2_ | CFG Regist | er | | | | | |
|--------------------------------------|---------------|----|--------------|------------|--------|-----|-------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | PHASE2[9:2] | | | | | | | | | |
| | R/W-00000000b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| PHASE2[1:0] RESERVED DCBLK2_DIS MUX2 | | | | | | | UX2 | | | |
| R/W-0000 | 000000b | | R-000b | | R/W-0b | R/W | V-00b | | | |

| | | 表 8-33. C | H2_CFG Reg | ister Field Descriptions |
|------|-------------|-----------|-----------------|--|
| Bit | Field | Туре | Reset | Description |
| 15:6 | PHASE2[9:0] | R/W | 0000000000 b | Channel 2 phase delay Phase delay in modulator clock cycles provided in two's complement format. See $\frac{1}{8}$ 8-5 for details. |
| 5:3 | RESERVED | R | 000ь | Reserved always reads 000b |
| 2 | DCBLK2_DIS | R/W | 0b | Channel 2 DC Block filter disable 0b = Controlled by DCBLOCK[3:0] (default) 1b = Disabled for this channel |
| 1:0 | MUX2 | R/W | 00Ь | Channel 2 input selection 00b = AIN2P and AIN2N (default) 01b = ADC inputs shorted 10b = Positive DC test signal 11b = Negative DC test signal |



8.6.21 CH2_OCAL_MSB Register (Address = 14h) [reset = 0000h]

The CH2_OCAL_MSB register is shown in \boxtimes 8-46 and described in \cancel{a} 8-34.

Return to the Summary Table.

図 8-46. CH2_OCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | | |
|----|---------------------|----|------------|------------|----|---|---|--|--|--|--|--|
| | OCAL2_MSB[15:8] | | | | | | | | | | | |
| | R/W-00000000000000b | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | | |
| | OCAL2_MSB[7:0] | | | | | | | | | | | |
| | | | R/W-000000 | 000000000b | | | | | | | | |

表 8-34. CH2_OCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|-----------------------|--|
| 15:0 | OCAL2_MSB[15:0] | R/W | 00000000 00000000b | Channel 2 offset calibration register bits [23:8] Value provided in two's complement format |

8.6.22 CH2_OCAL_LSB Register (Address = 15h) [reset = 0000h]

The CH2_OCAL_LSB register is shown in \boxtimes 8-47 and described in \cancel{k} 8-35.

Return to the Summary Table.

図 8-47. CH2_OCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
|----|----------------|----|--------|-------|----|---|---|--|--|--|--|
| | OCAL2_LSB[7:0] | | | | | | | | | | |
| | R/W-0000000b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | RESERVED | | | | | | | | | | |
| | | | R-0000 | 0000b | | | | | | | |

表 8-35. CH2_OCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|----------|--|
| 15:8 | OCAL2_LSB[7:0] | R/W | 0000000b | Channel 2 offset calibration register bits [7:0] |
| | | | | Value provided in two's complement format |
| 7:0 | RESERVED | R | 0000000b | Reserved |
| | | | | always reads 00000000b |

8.6.23 CH2_GCAL_MSB Register (Address = 16h) [reset = 8000h]

The CH2_GCAL_MSB register is shown in \boxtimes 8-48 and described in \cancel{B} 8-36.

Return to the Summary Table.

図 8-48. CH2_GCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | | |
|----|-------------------|----|------------|------------|----|---|---|--|--|--|--|--|
| | GCAL2_MSB[15:8] | | | | | | | | | | | |
| | R/W-100000000000b | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | | |
| | GCAL2_MSB[7:0] | | | | | | | | | | | |
| | | | R/W-100000 | 000000000b | | | | | | | | |
| 1 | | | | | | | | | | | | |

表 8-36. CH2_GCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|--------|--|
| 15:0 | GCAL2_MSB[15:0] | R/W | 000000 | Channel 2 gain calibration register bits [23:8] |
| | | | | Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |

8.6.24 CH2_GCAL_LSB Register (Address = 17h) [reset = 0000h]

The CH2_GCAL_LSB register is shown in \boxtimes 8-49 and described in \cancel{k} 8-37.

Return to the Summary Table.

図 8-49. CH2_GCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
|----|----------------|----|--------|-------|----|---|---|--|--|--|--|
| | GCAL2_LSB[7:0] | | | | | | | | | | |
| | R/W-0000000b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | RESERVED | | | | | | | | | | |
| | | | R-0000 | 0000b | | | | | | | |
| | | | | | | | | | | | |

表 8-37. CH2_GCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|----------|--|
| 15:8 | GCAL2_LSB[7:0] | R/W | 0000000b | Channel 2 gain calibration register bits [7:0] |
| | | | | Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |
| 7:0 | RESERVED | R | 0000000b | Reserved |
| | | | | always reads 00000000b |



8.6.25 CH3_CFG Register (Address = 18h) [reset = 0000h]

The CH3_CFG register is shown in \boxtimes 8-50 and described in $\cancel{5}$ 8-38.

Return to the Summary Table.

| 8 | | | | | | | | | | |
|---------------|--|--|--|--|--|--|--|--|--|--|
| PHASE3[9:2] | | | | | | | | | | |
| R/W-00000000b | | | | | | | | | | |
| 0 | | | | | | | | | | |
| 〈 3 | | | | | | | | | | |
| 00b | | | | | | | | | | |
| | | | | | | | | | | |

| | 表 8-38. CH3_CFG Register Field Descriptions | | | | | | | |
|------|---|------|-----------------|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | |
| 15:6 | PHASE3[9:0] | R/W | 0000000000 b | Channel 3 phase delay Phase delay in modulator clock cycles provided in two's complement format. See \gtrsim 8-5 for details. | | | | |
| 5:3 | RESERVED | R | 000b | Reserved always reads 0000000b | | | | |
| 2 | DCBLK3_DIS | R/W | Ob | Channel 3 DC Block filter disable 0b = Controlled by DCBLOCK[3:0] (default) 1b = Disabled for this channel | | | | |
| 1:0 | MUX3 | R/W | 00b | Channel 3 input selection 00b = AIN3P and AIN3N (default) 01b = ADC inputs shorted 10b = Positive DC test signal 11b = Negative DC test signal | | | | |

8.6.26 CH3_OCAL_MSB Register (Address = 19h) [reset = 0000h]

The CH3_OCAL_MSB register is shown in \boxtimes 8-51 and described in \cancel{B} 8-39.

Return to the Summary Table.

図 8-51. CH3_OCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
|--------------------|----------------|----|------------|------------|----|---|---|--|--|--|
| OCAL3_MSB[15:8] | | | | | | | | | | |
| R/W-0000000000000b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | OCAL3_MSB[7:0] | | | | | | | | | |
| | | | R/W-000000 | 000000000b | | | | | | |

表 8-39. CH3_OCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|-----------------------|--|
| 15:0 | OCAL3_MSB[15:0] | R/W | 00000000 00000000b | Channel 3 offset calibration register bits [23:8] Value provided in two's complement format |

8.6.27 CH3_OCAL_LSB Register (Address = 1Ah) [reset = 0000h]

The CH3_OCAL_LSB register is shown in \boxtimes 8-52 and described in \cancel{k} 8-40.

Return to the Summary Table.

図 8-52. CH3_OCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
|--------------|----------------|----|----|----|----|---|---|--|--|--|
| | OCAL3_LSB[7:0] | | | | | | | | | |
| R/W-0000000b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | RESERVED | | | | | | | | | |
| | R-0000000b | | | | | | | | | |

表 8-40. CH3_OCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|-------------------|--|
| 15:8 | OCAL3_LSB[7:0] | R/W | 0000000b | Channel 3 offset calibration register bits [7:0] |
| | | | | Value provided in two's complement format |
| 7:0 | RESERVED | R | 0000000b Reserved | |
| | | | | always reads 00000000b |



8.6.28 CH3_GCAL_MSB Register (Address = 1Bh) [reset = 8000h]

The CH3_GCAL_MSB register is shown in 図 8-53 and described in 表 8-41.

Return to the Summary Table.

図 8-53. CH3_GCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
|--------------------|----------------|----|------------|------------|----|---|---|--|--|--|
| GCAL3_MSB[15:8] | | | | | | | | | | |
| R/W-1000000000000b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | GCAL3_MSB[7:0] | | | | | | | | | |
| | | | R/W-100000 | d00000000b | | | | | | |

表 8-41. CH3_GCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|---------|--|
| 15:0 | GCAL3_MSB[15:0] | R/W | 000000 | Channel 3 gain calibration register bits [23:8] |
| | | | 0000000 | Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |

8.6.29 CH3_GCAL_LSB Register (Address = 1Ch) [reset = 0000h]

The CH3_GCAL_LSB register is shown in \boxtimes 8-54 and described in \cancel{k} 8-42.

Return to the Summary Table.

図 8-54. CH3_GCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|----------------|----------|----|--------|-------|----|---|---|--|--|
| GCAL3_LSB[7:0] | | | | | | | | | |
| R/W-0000000b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESERVED | | | | | | | | |
| | | | R-0000 | 0000b | | | | | |
| | | | | | | | | | |

表 8-42. CH3_GCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|---|--|
| 15:8 | GCAL3_LSB[7:0] | R/W | 0000000b Channel 3 gain calibration register bits [7:0] | |
| | | | | Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |
| 7:0 | RESERVED | R | 0000000b Reserved | |
| | | | | always reads 00000000b |

8.6.30 CH4_CFG Register (Address = 1Dh) [reset = 0000h]

The CH4_CFG register is shown in \boxtimes 8-55 and described in $\cancel{5}$ 8-43.

Return to the Summary Table.

| 図 8-55. CH4_CFG Register | | | | | | | | | | |
|--------------------------|----------------------|--------|----|----|------------|-----|-------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| PHASE4[9:2] | | | | | | | | | | |
| R/W-00000000b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| PHAS | PHASE4[1:0] RESERVED | | | | DCBLK4_DIS | MU | JX4 | | | |
| R/W-000 | 000000b | R-000b | | | R/W-0b | R/W | /-00b | | | |

| | 表 8-43. CH4_CFG Register Field Descriptions | | | | | | | | |
|------|---|------|-----------------|--|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | | |
| 15:6 | PHASE4[9:0] | R/W | 0000000000 b | Channel 4 phase delay Phase delay in modulator clock cycles provided in two's complement format. See \gtrsim 8-5 for details. | | | | | |
| 5:3 | RESERVED | R | 000b | Reserved always reads 000b | | | | | |
| 2 | DCBLK4_DIS | R/W | 0b | Channel 4 DC Block filter disable 0b = Controlled by DCBLOCK[3:0] (default) 1b = Disabled for this channel | | | | | |
| 1:0 | MUX4 | R/W | 00b | Channel 4 input selection 00b = AIN4P and AIN4N (default) 01b = ADC inputs shorted 10b = Positive DC test signal 11b = Negative DC test signal | | | | | |



8.6.31 CH4_OCAL_MSB Register (Address = 1Eh) [reset = 0000h]

The CH4_OCAL_MSB register is shown in \boxtimes 8-56 and described in \cancel{a} 8-44.

Return to the Summary Table.

図 8-56. CH4_OCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|----|--|----|----|----|----|---|---|--|--|
| | OCAL4_MSB[15:8] | | | | | | | | |
| | R/W-000000000000000000000000000000000000 | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | OCAL4_MSB[7:0] | | | | | | | | |
| | R/W-00000000000000 | | | | | | | | |

表 8-44. CH4_OCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|-----------------------|--|
| 15:0 | OCAL4_MSB[15:0] | R/W | 00000000 00000000b | Channel 4 offset calibration register bits [23:8] Value provided in two's complement format |

8.6.32 CH4_OCAL_LSB Register (Address = 1Fh) [reset = 0000h]

The CH4_OCAL_LSB register is shown in \boxtimes 8-57 and described in \cancel{k} 8-45.

Return to the Summary Table.

図 8-57. CH4_OCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|--------------|------------|----|---------|----------|----|---|---|--|--|
| | | | OCAL4_I | LSB[7:0] | | | | | |
| R/W-0000000b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESERVED | | | | | | | | |
| | R-0000000b | | | | | | | | |
| | | | | | | | | | |

表 8-45. CH4_OCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|--|---|
| 15:8 | OCAL4_LSB[7:0] | R/W | 00000000b Channel 4 offset calibration register bits [7:0] | |
| | | | | Value provided in two's complement format |
| 7:0 | RESERVED | R | 0000000b | Reserved |
| | | | | always reads 00000000b |



8.6.33 CH4_GCAL_MSB Register (Address = 20h) [reset = 8000h]

The CH4_GCAL_MSB register is shown in \boxtimes 8-58 and described in \cancel{a} 8-46.

Return to the Summary Table.

図 8-58. CH4_GCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|----|--------------------|----|---------|------------|----|---|---|--|--|
| | | | GCAL4_N | /ISB[15:8] | | | | | |
| | R/W-1000000000000b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | GCAL4_MSB[7:0] | | | | | | | | |
| | R/W-100000000000b | | | | | | | | |

表 8-46. CH4_GCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|--------|---|
| 15:0 | GCAL4_MSB[15:0] | R/W | 000000 | Channel 4 gain calibration register bits [23:8] Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |

8.6.34 CH4_GCAL_LSB Register (Address = 21h) [reset = 0000h]

The CH4_GCAL_LSB register is shown in \boxtimes 8-59 and described in \cancel{k} 8-47.

Return to the Summary Table.

図 8-59. CH4_GCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|----|--------------|----|---------|----------|----|---|---|--|--|
| | | | GCAL4_I | LSB[7:0] | | | | | |
| | R/W-0000000b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESERVED | | | | | | | | |
| | R-0000000b | | | | | | | | |
| | | | | | | | | | |

表 8-47. CH4_GCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|---|--|
| 15:8 | GCAL4_LSB[7:0] | R/W | 0000000b Channel 4 gain calibration register bits [7:0] | |
| | | | | Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |
| 7:0 | RESERVED | R | 0000000b | Reserved |
| | | | | always reads 00000000b |



8.6.35 CH5_CFG Register (Address = 22h) [reset = 0000h]

The CH5_CFG register is shown in \boxtimes 8-60 and described in $\cancel{5}$ 8-48.

Return to the Summary Table.

| 図 8-60. CH5_CFG Register | | | | | | | | |
|------------------------------|--------------------------------------|----|----|----|----|-----|-------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| PHASE5[9:2] | | | | | | | | |
| R/W-00000000b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| PHASE | PHASE5[1:0] RESERVED DCBLK5_DIS MUX5 | | | | | | JX5 | |
| R/W-000000000b R-000b R/W-0b | | | | | | R/W | /-00b | |

| | | 表 8-48. CH5 | 5_CFG Reg | ister Field Descriptions |
|------|-------------|-------------|-----------------|--|
| Bit | Field | Туре | Reset | Description |
| 15:6 | PHASE5[9:0] | R/W | 0000000000 b | Channel 5 phase delay Phase delay in modulator clock cycles provided in two's complement format. See $\gtrsim 8-5$ for details. |
| 5:3 | RESERVED | R | 000b | Reserved always reads 000b |
| 2 | DCBLK5_DIS | R/W | Ob | Channel 5 DC Block filter disable 0b = Controlled by DCBLOCK[3:0] (default) 1b = Disabled for this channel |
| 1:0 | MUX5 | R/W | 00b | Channel 5 put selection 00b = AIN5P and AIN5N (default) 01b = ADC inputs shorted 10b = Positive DC test signal 11b = Negative DC test signal |

8.6.36 CH5_OCAL_MSB Register (Address = 23h) [reset = 0000h]

CH5_OCAL_MSB is shown in \boxtimes 8-61 and described in $\cancel{8}$ 8-49.

Return to the Summary Table.

図 8-61. CH5_OCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|----|--|----|---------|-----------|----|---|---|--|--|
| | | | OCAL5_N | MSB[15:8] | | | | | |
| | R/W-000000000000000000000000000000000000 | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | OCAL5_MSB[7:0] | | | | | | | | |
| | R/W-000000000000b | | | | | | | | |

表 8-49. CH5_OCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|-----------------------|--|
| 15:0 | OCAL5_MSB[15:0] | R/W | 00000000 00000000b | Channel 5 offset calibration register bits [23:8] Value provided in two's complement format |

8.6.37 CH5_OCAL_LSB Register (Address = 24h) [reset = 0000h]

The CH5_OCAL_LSB register is shown in \boxtimes 8-62 and described in \cancel{k} 8-50.

Return to the Summary Table.

図 8-62. CH5_OCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
|----------------|----|----|----|----|----|---|---|
| OCAL5_LSB[7:0] | | | | | | | |
| R/W-0000000b | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | | | | | | | |
| R-0000000b | | | | | | | |
| | | | | | | | |

表 8-50. CH5_OCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|----------|--|
| 15:8 | OCAL5_LSB[7:0] | R/W | 0000000b | Channel 5 offset calibration register bits [7:0] |
| | | | | Value provided in two's complement format |
| 7:0 | RESERVED | R | 0000000b | Reserved |
| | | | | always reads 00000000b |



8.6.38 CH5_GCAL_MSB Register (Address = 25h) [reset = 8000h]

The CH5_GCAL_MSB register is shown in \boxtimes 8-63 and described in \cancel{a} 8-51.

Return to the Summary Table.

図 8-63. CH5_GCAL_MSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
|-------------------|----|----|----|----|----|---|---|--|
| GCAL5_MSB[15:8] | | | | | | | | |
| R/W-100000000000b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| GCAL5_MSB[7:0] | | | | | | | | |
| R/W-10000000000b | | | | | | | | |

表 8-51. CH5_GCAL_MSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|--------|---|
| 15:0 | GCAL5_MSB[15:0] | R/W | 000000 | Channel 5 gain calibration register bits [23:8] Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |

8.6.39 CH5_GCAL_LSB Register (Address = 26h) [reset = 0000h]

The CH5_GCAL_LSB register is shown in \boxtimes 8-64 and described in \cancel{k} 8-52.

Return to the Summary Table.

図 8-64. CH5_GCAL_LSB Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
|--------------|----|----|---------|----------|----|---|---|
| | | | GCAL5_I | _SB[7:0] | | | |
| R/W-0000000b | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | | | | | | | |
| R-0000000b | | | | | | | |

表 8-52. CH5_GCAL_LSB Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|----------|--|
| 15:8 | GCAL5_LSB[7:0] | R/W | 0000000b | Channel 5 gain calibration register bits [7:0] |
| | | | | Unsigned number for the gain range from 0.0 to $2.0 \cdot (2^{24} - 1) / 2^{24}$ |
| 7:0 | RESERVED | R | 0000000b | Reserved |
| | | | | always reads 00000000b |

8.6.40 REGMAP_CRC Register (Address = 3Eh) [reset = 0000h]

The REGMAP_CRC register is shown in \boxtimes 8-65 and described in \cancel{a} 8-53.

Return to the Summary Table.

図 8-65. REGMAP_CRC Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
|-----------------|----|----|----|----|----|---|---|--|
| REG_CRC[15:8] | | | | | | | | |
| R-000000000000b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| REG_CRC[7:0] | | | | | | | | |
| R-00000000000b | | | | | | | | |
| | | | | | | | | |

表 8-53. REGMAP_CRC Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-----------------------|------------------------|
| 15:0 | REG_CRC[15:0] | R | 00000000 00000000b | Register map CRC value |

8.6.41 RESERVED Register (Address = 3Fh) [reset = 0000h]

The RESERVED register is shown in \boxtimes 8-66 and described in \cancel{R} 8-54.

Return to the Summary Table.

🛛 8-66. RESERVED Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|--------------------|----|----|----|----|----|---|---|--|--|
| RESERVED | | | | | | | | | |
| R/W-0000000000000b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| RESERVED | | | | | | | | | |
| R/W-00000000000b | | | | | | | | | |

表 8-54. RESERVED Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------|------|-----------------------|---|
| 15:0 | RESERVED | R/W | 00000000 00000000b | Reserved Always write 000000000000000b |



9 Application and Implementation

注

以下のアプリケーション情報は、TIの製品仕様に含まれるものではなく、TIではその正確性または完全性を保証いたしません。個々の目的に対する製品の適合性については、お客様の責任で判断していただくことになります。お客様は自身の設計実装を検証しテストすることで、システムの機能を確認する必要があります。

9.1 Application Information

9.1.1 Unused Inputs and Outputs

Leave any unused analog inputs floating or connect them to AGND.

Do not float unused digital inputs because excessive power-supply leakage current can result. Tie all unused digital inputs to the appropriate levels, DVDD or DGND. Leave the DRDY pin unconnected or connect this pin to DVDD using a weak pullup resistor if unused.

9.1.2 Antialiasing

An analog low-pass filter is required in front of each of the channel inputs to prevent out-of-band noise and interferers from coupling into the band of interest. Because the ADS131M06-Q1 is a delta-sigma ADC, the integrated digital filter provides substantial attenuation for frequencies outside of the band of interest up to the frequencies adjacent to f_{MOD}. Therefore, a single-order RC filter provides sufficient antialiasing protection in the vast majority of applications.

Choosing the values of the resistor and capacitor depends on the desired cutoff frequency, limiting source impedance for the ADC inputs, and providing enough instantaneous charge to the ADC input sampling circuit through the filter capacitor. \boxtimes 9-1 shows the recommended filter component values. These recommendations are sufficient for CLKIN frequencies between 2 MHz and 8.2 MHz.

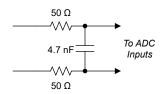


図 9-1. Recommended Antialiasing Circuitry



9.1.3 Minimum Interface Connections

⊠ 9-2 depicts how the ADS131M06-Q1 can be configured for the minimum number of interface pins. This configuration is useful when using data isolation to minimize the number of isolation channels required or when the microcontroller (MCU) pins are limited.

The CLKIN pin requires an LVCMOS clock that can be either generated by the MCU or created using a local LVCMOS output device. Tie the <u>SYNC/RESET</u> pin to DVDD in hardware if unused. The <u>DRDY</u> pin can be left floating if unused. Connect either <u>SYNC/RESET</u> or <u>DRDY</u> to the MCU to ensure the MCU stays synchronized to ADC conversions. If the MCU provides CLKIN, the CLKIN periods can be counted to determine the sample period rather than forcing synchronization using the <u>SYNC/RESET</u> pin or monitoring the <u>DRDY</u> pin. Synchronization cannot be regained if a bit error occurs on the clock and samples can be missed if the <u>SYNC/RESET</u> or <u>DRDY</u> pins are not used. <u>CS</u> can be tied low in hardware if the ADS131M06-Q1 is the only device on the SPI bus. Ensure the data input and output CRC are enabled and are used to guard against faulty register reads and writes if <u>CS</u> is tied low permanently.

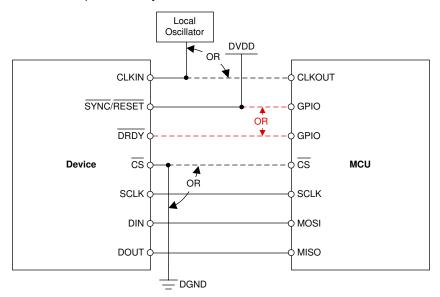


図 9-2. Minimum Connections Required to Operate the ADS131M06-Q1



9.1.4 Multiple Device Configuration

Multiple ADS131M06-Q1 devices can be arranged to capture all signals simultaneously. The same clock must be provided to all devices and the <u>SYNC/RESET</u> pins must be strobed simultaneously at least one time to align the sample periods internally between devices. The phase settings of each device can be changed uniquely, but the host must take care to record which channel in the group of devices represents the *zero* phase.

The devices can also share the SPI bus where only the \overline{CS} pins for each device are unique. Each device can be addressed sequentially by asserting \overline{CS} for the device that the host wishes to communicate with. The DOUT pin remains high impedance when the \overline{CS} pin is high, allowing the DOUT lines to be shared between devices as long as no two devices sharing the bus simultaneously have their \overline{CS} pins low. \boxtimes 9-3 shows multiple devices configured for simultaneous data acquisition while sharing the SPI bus.

Monitoring the DRDY output of only one of the devices is sufficient because all devices convert simultaneously.

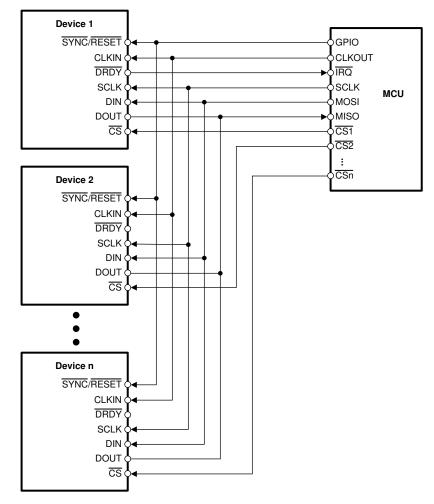


図 9-3. Multiple Device Configuration



9.1.5 Troubleshooting

 \pm 9-1 lists common issues faced when designing with the ADS131M06-Q1 and the corresponding solutions. This list is not comprehensive.

| ISSUE | POSSIBLE ROOT CAUSE | POSSIBLE SOLUTION |
|--|---|--|
| The DRDY pin is toggling at half the expected frequency. | ADC conversion data are not being read. The two-deep ADC data FIFO overflows and triggers DRDY one time every two ADC data periods. | Read data after each DRDY falling edge after following the recommendations given in the <i>Collecting Data for the First Time or After a Pause in Data Collection</i> section. |
| The F_RESYNC bit is set in the STATUS word even though this bit was already cleared. | The SYNC/RESET pin is being toggled asynchronously to CLKIN. | The SYNC/RESET pin functions as a constant synchronization check, rather than a <i>convert start</i> pin. See the <i>Synchronization</i> section for more details on the intended usage of the SYNC/RESET pin. |
| The same ADC conversion data are output twice before changing. | The entire frame is not being sent to the ADC. The ADC does not recognize data as being read. | Read all data words in the output data frame, including those for channels that are disabled. |

表 9-1. Troubleshooting Common Issues Using the ADS131M06-Q1

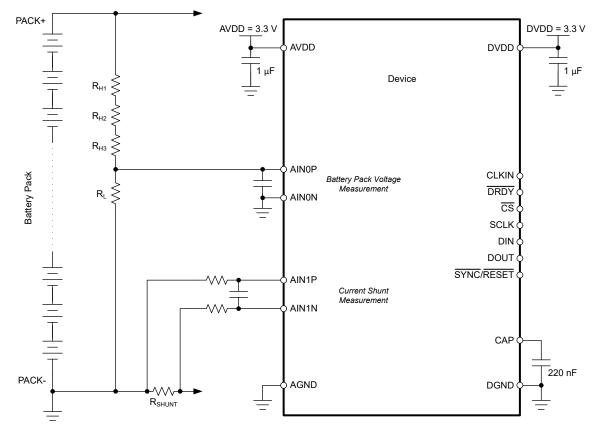


9.2 Typical Application

This section describes a typical battery management system (BMS) application circuit using the ADS131M06-Q1. The device serves the following primary functions in this BMS:

- Measure battery current with high resolution and accuracy using a low-side current shunt sensor
- · Measure peak currents and detect overcurrent or short-circuit conditions
- Measure battery-pack voltage using a high-voltage resistor divider

9-4 shows the front-end for the battery management system circuit design.





9.2.1 Design Requirements

| 表 9-2. Design Requirement | ts | remer | Requi | esign | 9-2. E | 表 | |
|---------------------------|----|-------|-------|-------|--------|---|--|
|---------------------------|----|-------|-------|-------|--------|---|--|

| VALUE | | | | | | | | | |
|----------------------------------|--|--|--|--|--|--|--|--|--|
| | | | | | | | | | |
| | | | | | | | | | |
| ±5 kA | | | | | | | | | |
| 35 μΩ | | | | | | | | | |
| 1 ms | | | | | | | | | |
| Battery-Pack Voltage Measurement | | | | | | | | | |
| 0 V to 800 V | | | | | | | | | |
| | | | | | | | | | |



9.2.2 Detailed Design Procedure

The following sections provide guidelines for selecting the external components and the configuration of the ADS131M06-Q1 for the various measurements in this application example.

9.2.2.1 Current Shunt Measurement

In a typical BMS, the current through the shunt resistor must be measured in both directions for charging and discharging the battery pack. In an overcurrent or short-circuit condition, the current can be as high as $I_{BAT_MAX} = \pm 5$ kA in this example application. Therefore, the maximum voltage drop across the shunt is up to $V_{SHUNT} = R_{SHUNT} \times I_{BAT_MAX} = 35 \ \mu\Omega \times \pm 4 \ kA = \pm 140 \ mV$.

To measure this shunt voltage, configure channel 1 of the ADS131M06-Q1 for gain = 8, which allows differential voltage measurements of $V_{IN1} = V_{AIN1P} - V_{AIN1N} = \pm V_{REF} / 8 = \pm 1.2 \text{ V} / 8 = \pm 150 \text{ mV}$. The integrated charge pump in the device allows voltage measurements 1.3 V below AGND while using a unipolar analog power supply. This bipolar voltage measurement capability is important because one side of the shunt is connected to the same GND potential as the AGND pin of the ADS131M06-Q1, which means that the absolute voltage that the device must measure is up to 140 mV below AGND.

To enable fast overcurrent detection within 1 ms while providing high accuracy and resolution, operate the ADS131M06-Q1 at 4 kSPS (OSR = 1024, high-resolution mode) using global-chop mode. Global-chop mode enables measurements with minimal offset error over temperature and time. The conversion time using these settings is 0.754 ms according to \neq 9. The input-referred noise is approximately 2.70 μ V_{RMS} / $\sqrt{2}$ = 1.91 μ V_{RMS} following the explanations in the *Noise Measurements* section. Thus, currents as small as 1.91 μ V_{RMS} / 35 μ Ω = 55 mA can be resolved. The resolution can be further improved by averaging the conversion results over a longer period of time in the microcontroller that interfaces with the ADS131M06-Q1.

9.2.2.2 Battery Pack Voltage Measurement

The 800-V battery-pack voltage is divided down to the voltage range of the ADS131M06-Q1 using a high-voltage resistor divider (R_{H1}, R_{H2}, R_{H3}, and R_L). Gain = 1 is used for channel 0 in this case to allow differential voltage measurements of V_{IN0} = V_{AIN0P} - V_{AIN0N} = \pm 1.2 V. The battery-pack voltage measurement is a unipolar, single-ended measurement. Thus, only the voltage range from 0 V to 1.2 V of the ADS131M06-Q1 is used. \pm 11 calculates the resistor divider ratio.

$$V_{IN} / V_{BAT MAX} = 1.2 V / 800 V = R_L / (R_L + R_{H1} + R_{H2} + R_{H3})$$
(11)

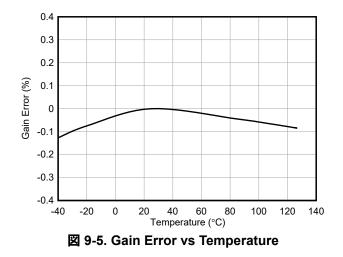
The leakage current drawn by the resistor divider must be less than 100 μ A in this example to avoid unnecessarily draining the battery. The resistance of the divider must therefore be larger than R_{TOTAL} \geq V_{BAT_MAX} / I_{LEAKAGE} = 800 V / 100 μ A = 8 M Ω . The resistor values are chosen as R_{H1} = R_{H2} = R_{H3} = 2.8 M Ω and R_L = 12.4 k Ω . Thus, the maximum voltage across R_L is 1.18 V at V_{BAT_MAX} = 800 V, leaving some headroom to the maximum input voltage of 1.2 V of the ADS131M06-Q1.

The maximum resistance of a single resistor that can be used in an automotive circuit design is often limited to a certain value. Also, the maximum voltage a single resistor can withstand is limited. These reasons are why the high-side resistor of the divider is split into multiple resistors (R_{H1} , R_{H2} , and R_{H3}). Another reason is that in case a single resistor has a short-circuit fault, the remaining resistors still limit the current into the ADS131M06-Q1 analog input pin (AIN0P) to safe levels.



9.2.3 Application Curve

⊠ 9-5 shows the gain error of the current measurement (ADC channel 1) over temperature excluding the error of the shunt. The gain error is calibrated at 25°C.





9.3 Power Supply Recommendations

9.3.1 CAP Pin Behavior

The ADS131M06-Q1 core digital voltage of 1.8 V is created from an internal LDO from DVDD. The CAP pin outputs the LDO voltage created from the DVDD supply and requires an external bypass capacitor. When operating from DVDD > 2.7 V, place a 220-nF capacitor on the CAP pin to DGND. If DVDD \leq 2 V, tie the CAP pin directly to the DVDD pin and decouple the star-connected pins using a 100-nF capacitor to DGND.

9.3.2 Power-Supply Sequencing

The power supplies can be sequenced in any order but the analog and digital inputs must never exceed the respective analog or digital power-supply voltage limits.

9.3.3 Power-Supply Decoupling

Good power-supply decoupling is important to achieve optimum performance. AVDD and DVDD must each be decoupled with a 1- μ F capacitor. Place the bypass capacitors as close to the power-supply pins of the device as possible with low-impedance connections. Using multilayer ceramic chip capacitors (MLCCs) that offer low equivalent series resistance (ESR) and inductance (ESL) characteristics are recommended for power-supply decoupling purposes. For very sensitive systems, or for systems in harsh noise environments, avoiding the use of vias for connecting the capacitors to the device pins can offer superior noise immunity. The use of multiple vias in parallel lowers the overall inductance and is beneficial for connections to ground planes. The analog and digital ground are recommended to be connected together as close to the device as possible.

9.4 Layout

9.4.1 Layout Guidelines

For best performance, dedicate an entire PCB layer to a ground plane and do not route any other signal traces on this layer. However, depending on restrictions imposed by specific end equipment, a dedicated ground plane may not be practical. If ground plane separation is necessary, make a direct connection of the planes at the ADC. Do not connect individual ground planes at multiple locations because this configuration creates ground loops.

Route digital traces away from all analog inputs and associated components in order to minimize interference.

Use C0G capacitors on the analog inputs. Use ceramic capacitors (for example, X7R grade) for the powersupply decoupling capacitors. High-K capacitors (Y5V) are not recommended. Place the required capacitors as close as possible to the device pins using short, direct traces. For optimum performance, use low-impedance connections on the ground-side connections of the bypass capacitors.

When applying an external clock, be sure the clock is free of overshoot and glitches. A source-termination resistor placed at the clock buffer often helps reduce overshoot. Glitches present on the clock input can lead to noise within the conversion data.



9.4.2 Layout Example

☑ 9-6 shows an example layout of the ADS131M06-Q1 requiring a minimum of two PCB layers. In general, analog signals and planes are partitioned to the left and digital signals and planes to the right.

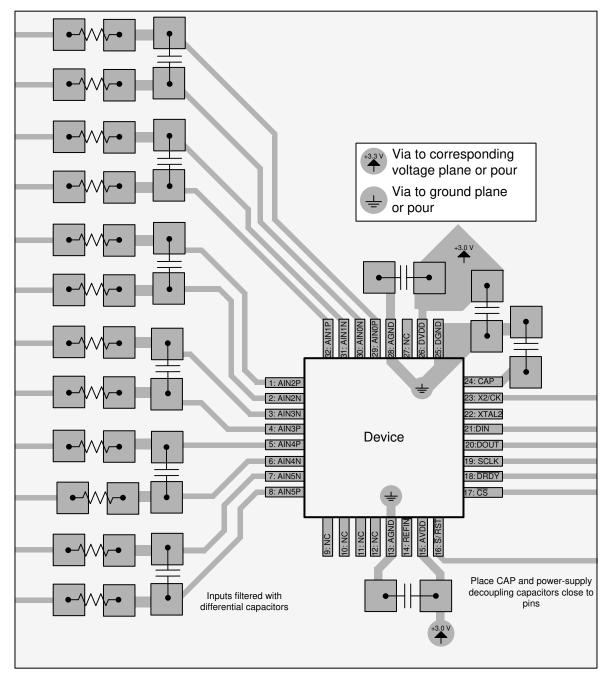


図 9-6. Layout Example



10 Device and Documentation Support

10.1 Documentation Support

10.1.1 Related Documentation

For related documentation see the following:

• Texas Instruments, REF50xx Low-Noise, Very Low Drift, Precision Voltage Reference data sheet

10.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

10.3 サポート・リソース

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10.4 Trademarks

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10.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

10.6 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------------|----------------------|--------------|-------------------------|---------|
| ADS131M06QPBSRQ1 | ACTIVE | TQFP | PBS | 32 | 1000 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | A31M06Q | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF ADS131M06-Q1 :



www.ti.com

Catalog : ADS131M06

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

PBS (S-PQFP-G32)

PLASTIC QUAD FLATPACK



B. This drawing is subject to change without notice.



PBS (S-PQFP-G32)

PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
 - E. Customers should contact their board fabrication site for recommended solder mask tolerances between and around signal pads.



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